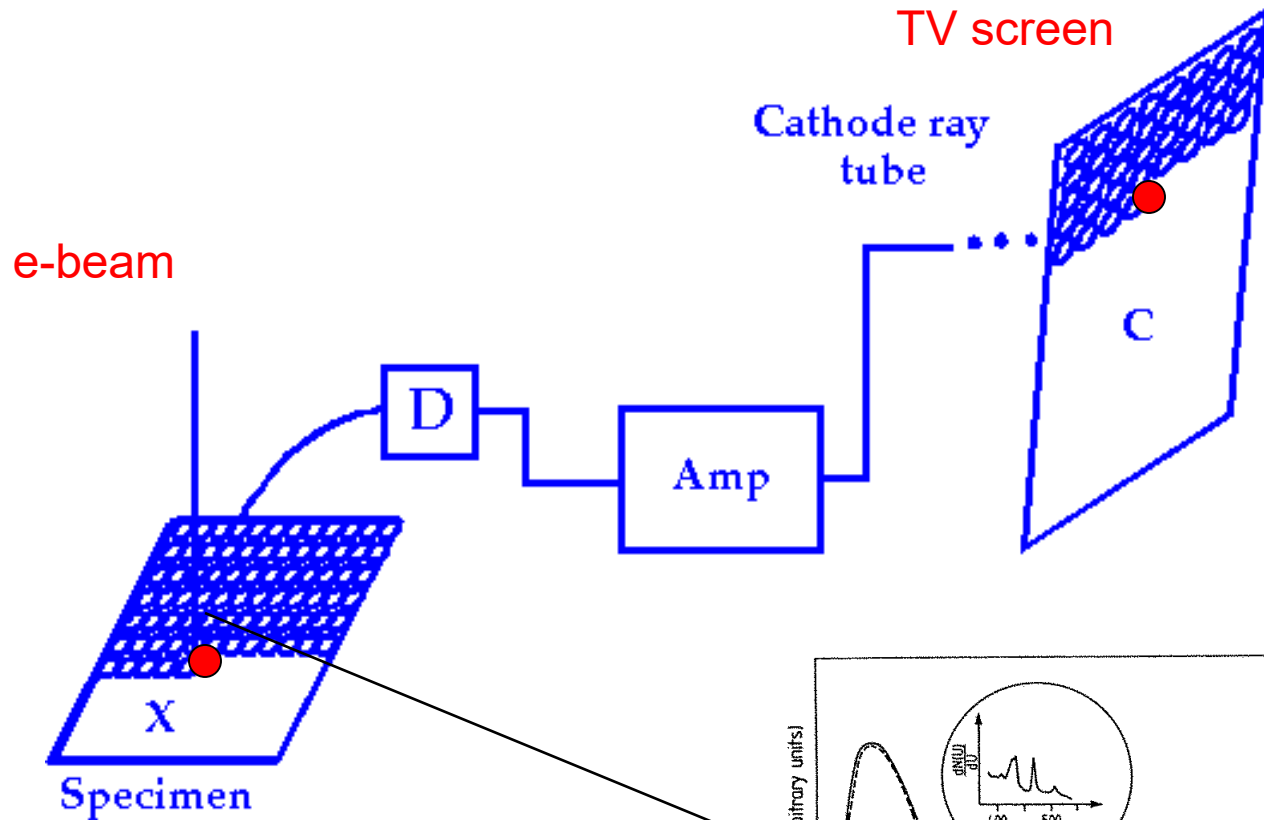


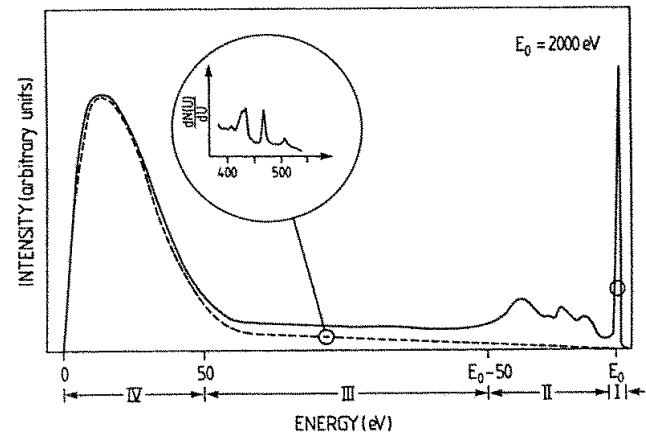


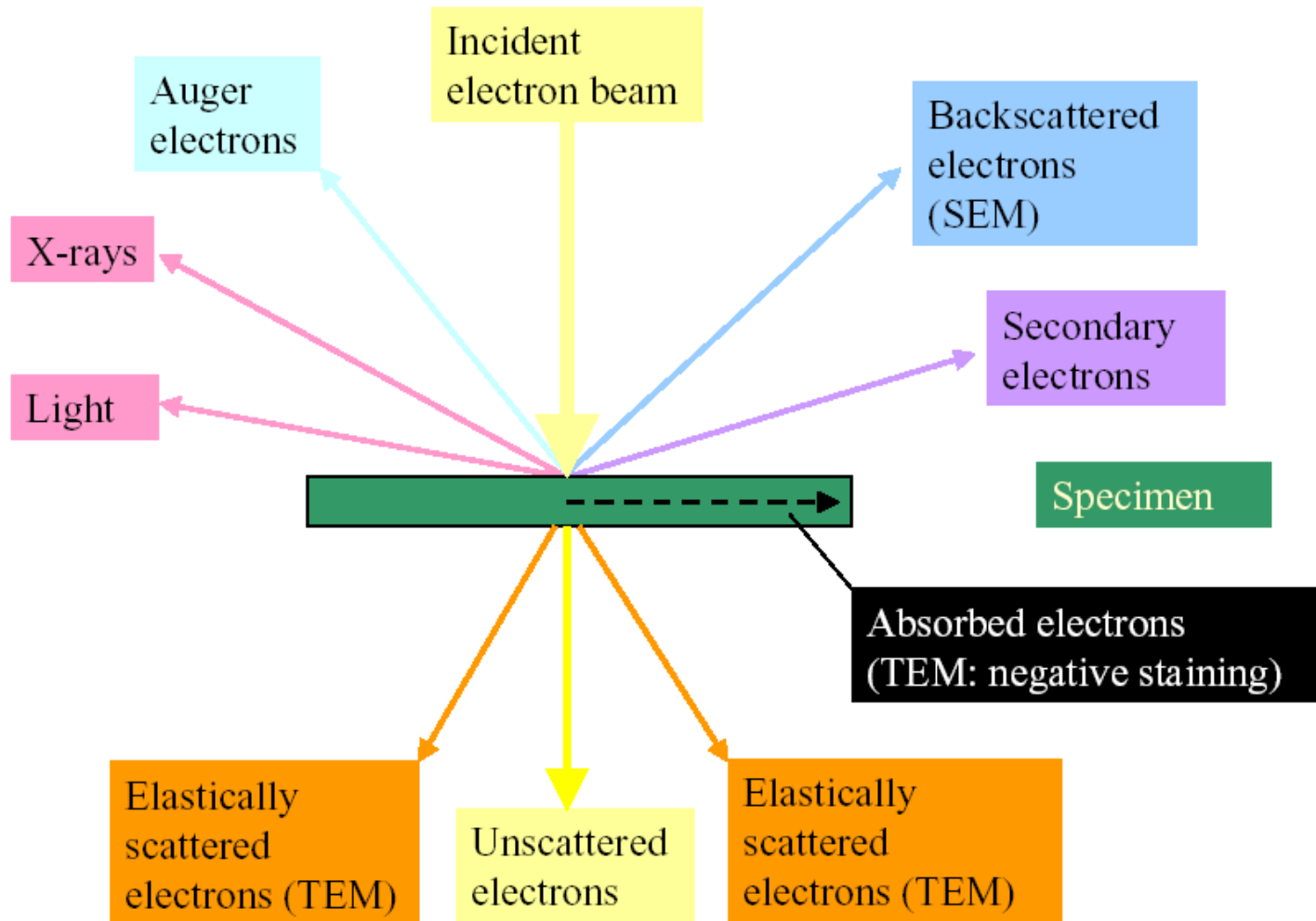
A number of different detectors can be incorporated into the chamber surrounding the specimen.

Image Formation



The selection of signal





Interaction of electron with specimen

Detectors

Backscattered electron detector:
(Solid-State Detector)

Secondary electron detector:
(Everhart-Thornley)

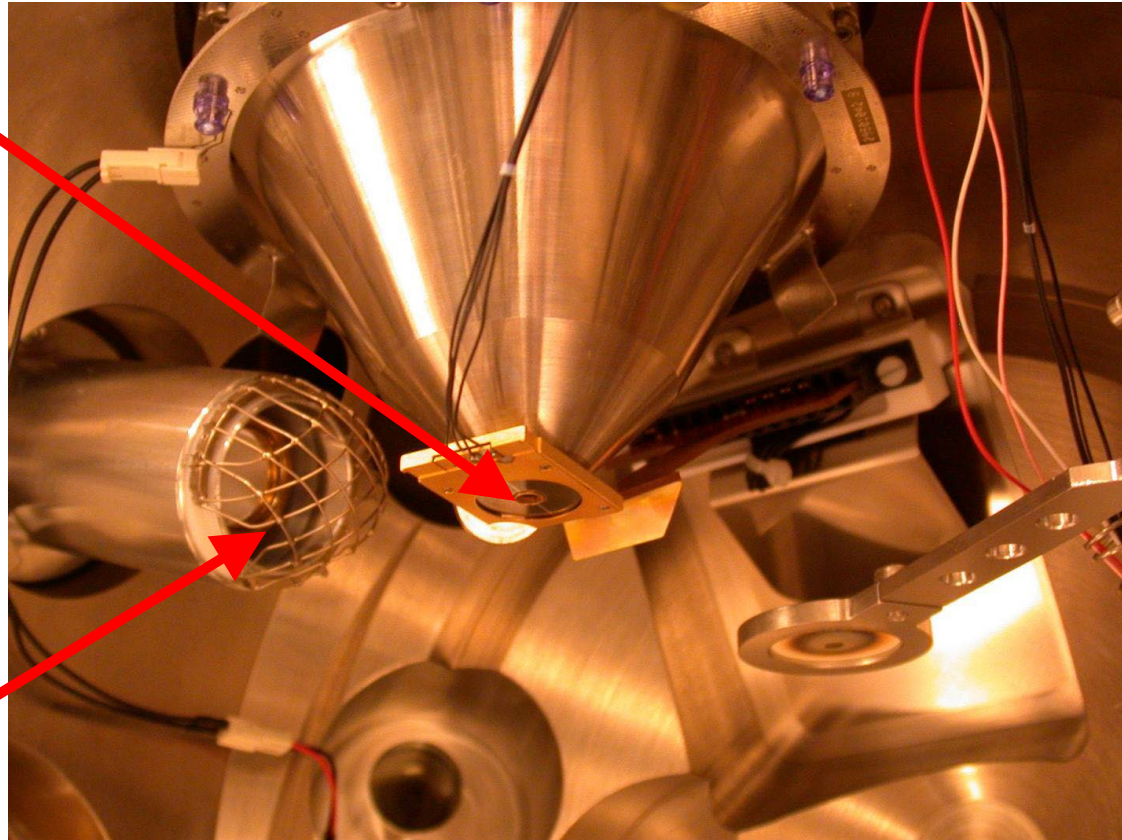
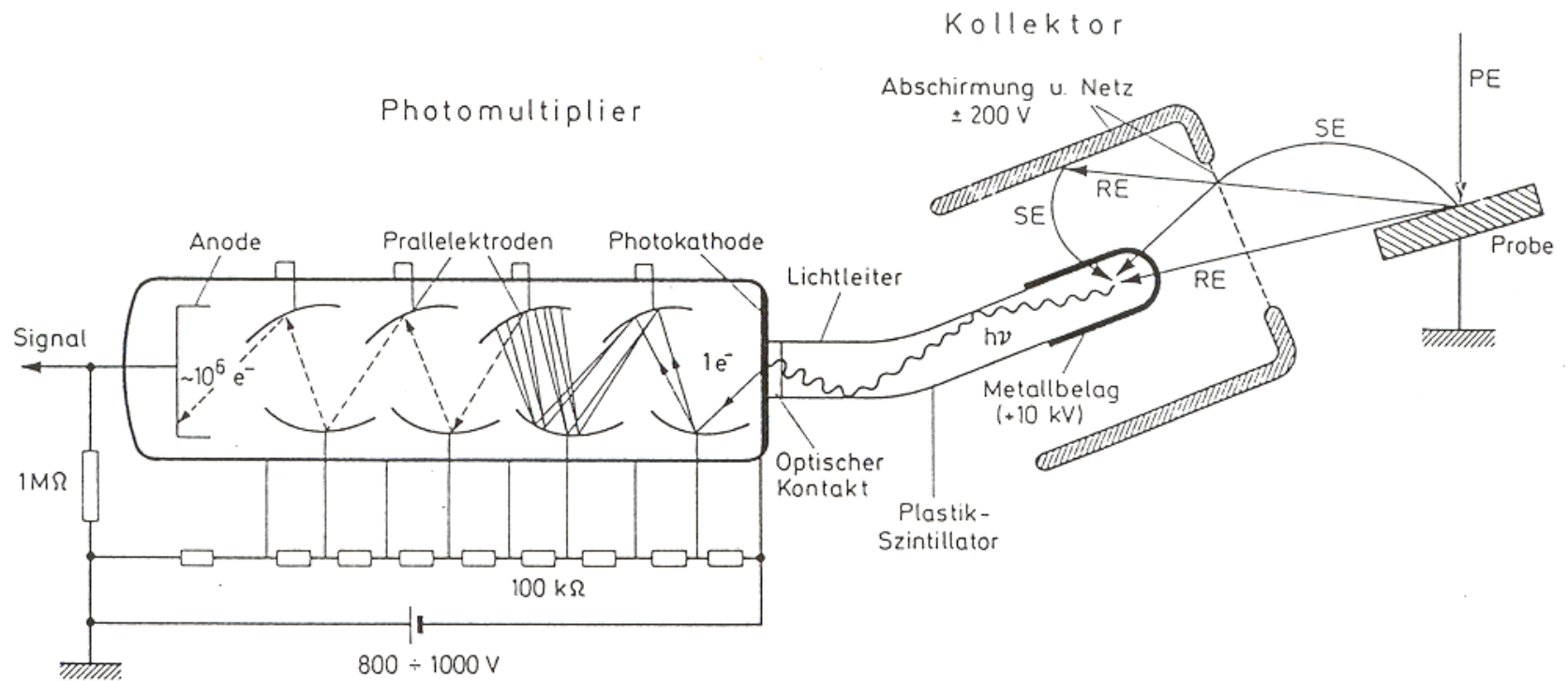


Image: Anders W. B. Skilbred, UiO

Detector for secondary electrons

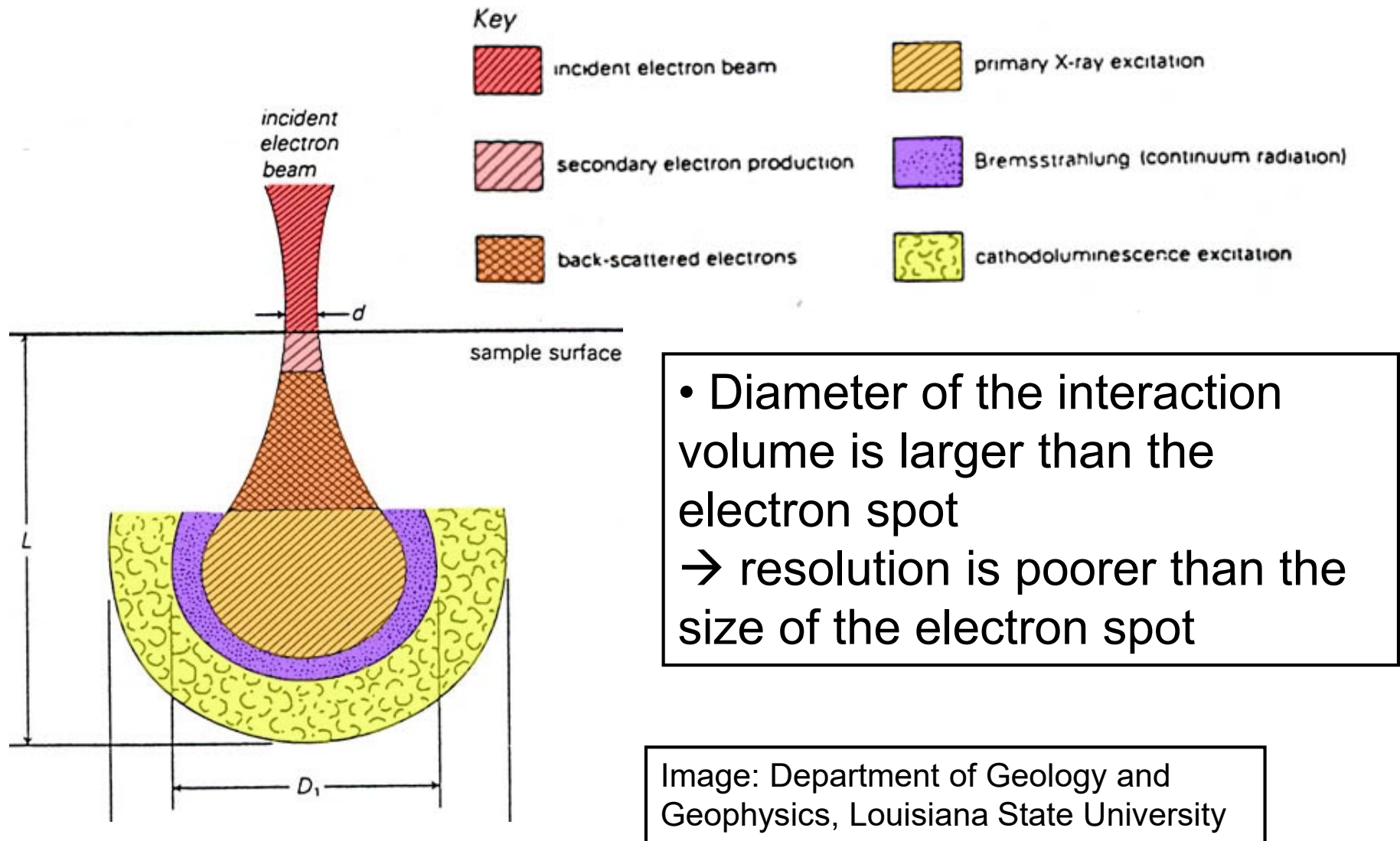
The most common scintillator is consisting of Y_2SiO_5 doped with cerium – luminescent material which changes electrons into photons – at photocathode change of photons into electrons – these are multiplied then



The \$64,000 Question

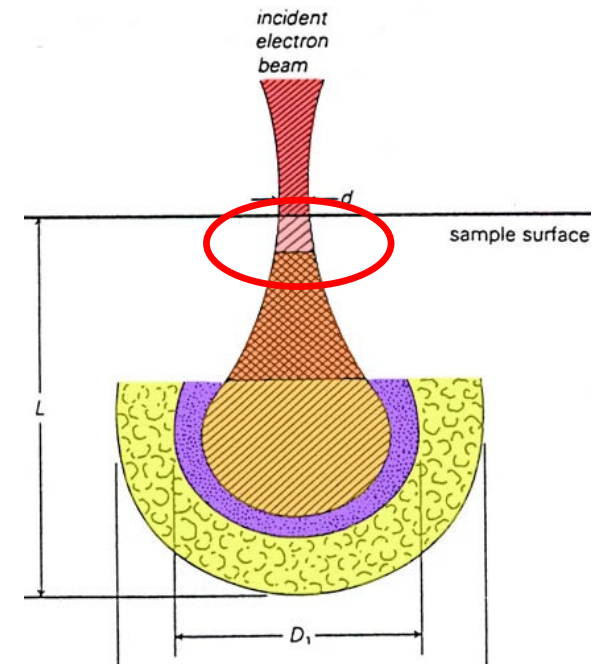
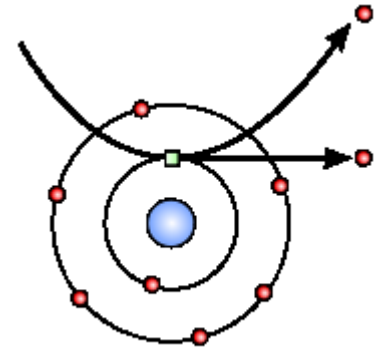
- Do we need to consider coherence?
- Formation of probe in SEM is coherent
- Image/Contrast Mechanisms
 - At low resolution many are incoherent, depend only upon $|\psi(r)|^2 = \rho(r)$
 - These images are “simple”, interpretation similar to light images
 - At high resolution ($\sim 1\text{nm}$) coherence *cannot* be neglected
 - Hence in most cases (lower resolution) SEM is simple.

Where does the signals come from?



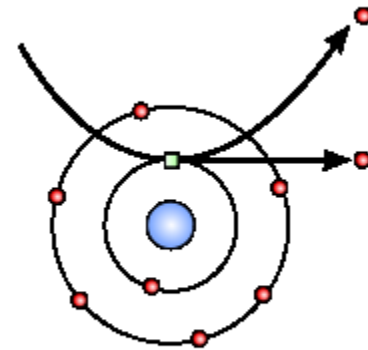
Secondary electrons (SE)

- Generated from the collision between the incoming electrons and the loosely bonded outer electrons
- Low energy electrons ($\sim 10\text{-}50\text{ eV}$)
- Only SE generated close to surface escape (topographic information is obtained)
- Number of SE is greater than the number of incoming electrons
- We differentiate between SE1 and SE2



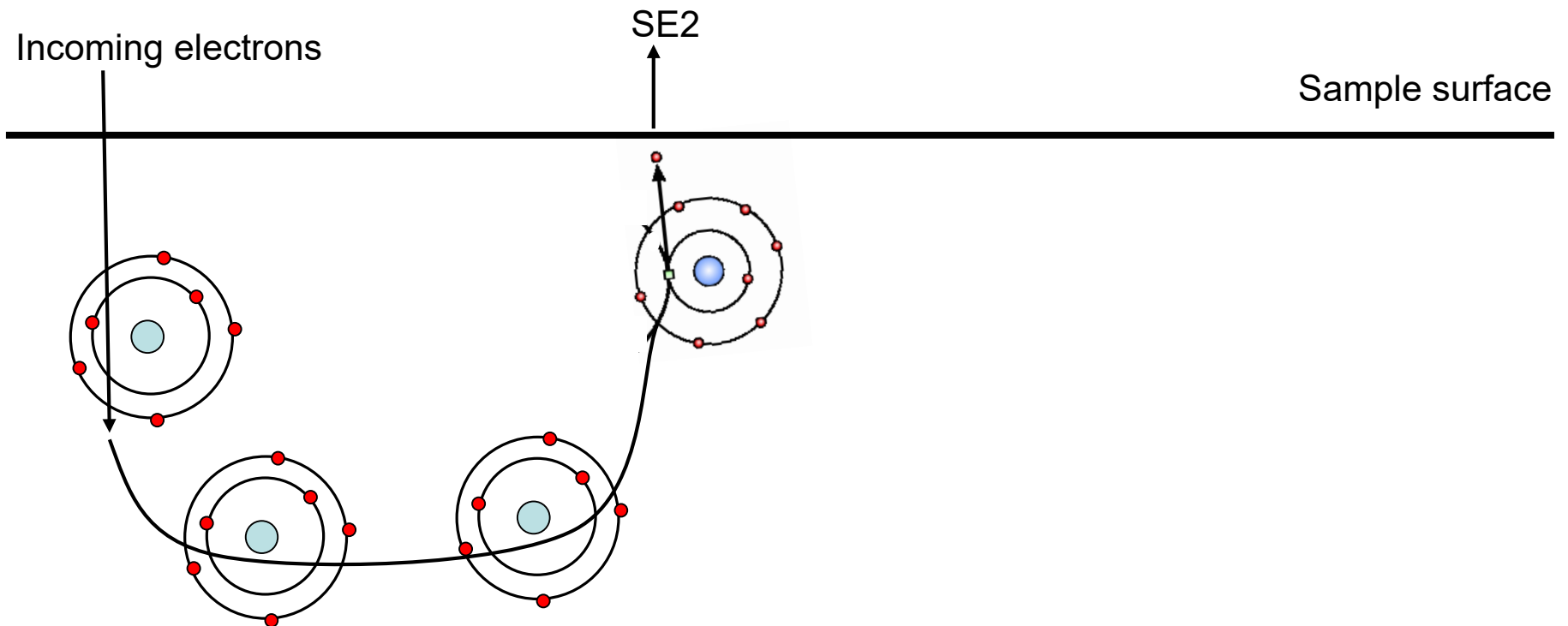
SE1

- The secondary electrons that are generated by the incoming electron beam as they enter the surface
- High resolution signal with a resolution which is only limited by the electron beam diameter



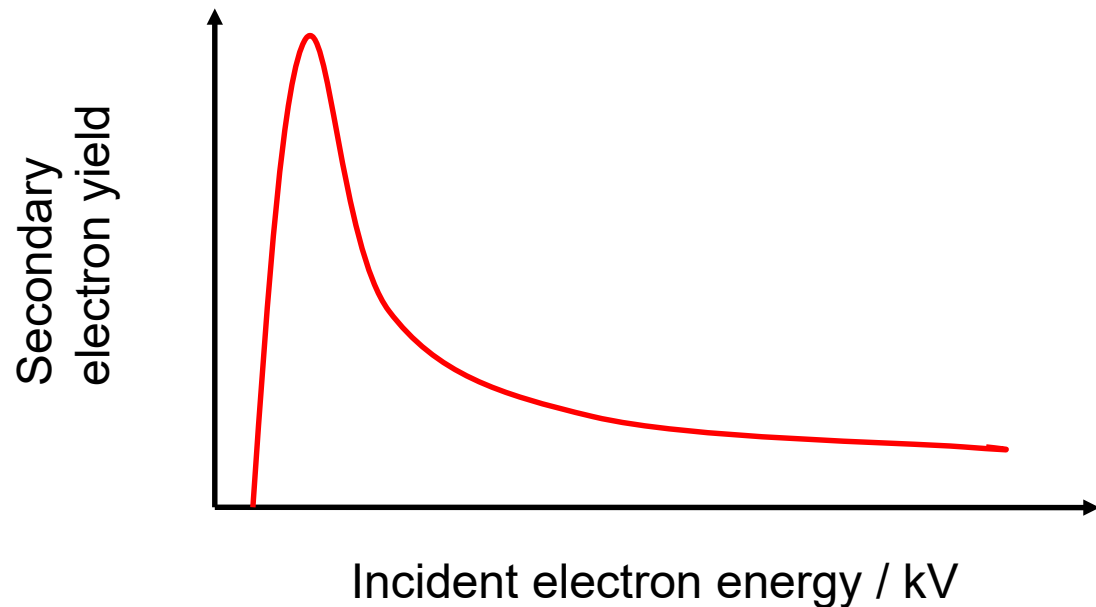
SE2

- The secondary electrons that are generated by the backscattered electrons that have returned to the surface after several inelastic scattering events
- SE2 come from a surface area that is bigger than the spot from the incoming electrons → resolution is poorer than for SE1 exclusively



Factors that affect SE emission

1. Work function of the surface
2. Beam energy and beam current
 - Electron yield goes through a maximum at low acc. voltage, then decreases with increasing acc. voltage



Factors that affect SE2 emission

3. Atomic number (Z)

- More SE2 are created with increasing Z
- The Z -dependence is more pronounced at lower beam energies

4. The local curvature of the surface (the most important factor)

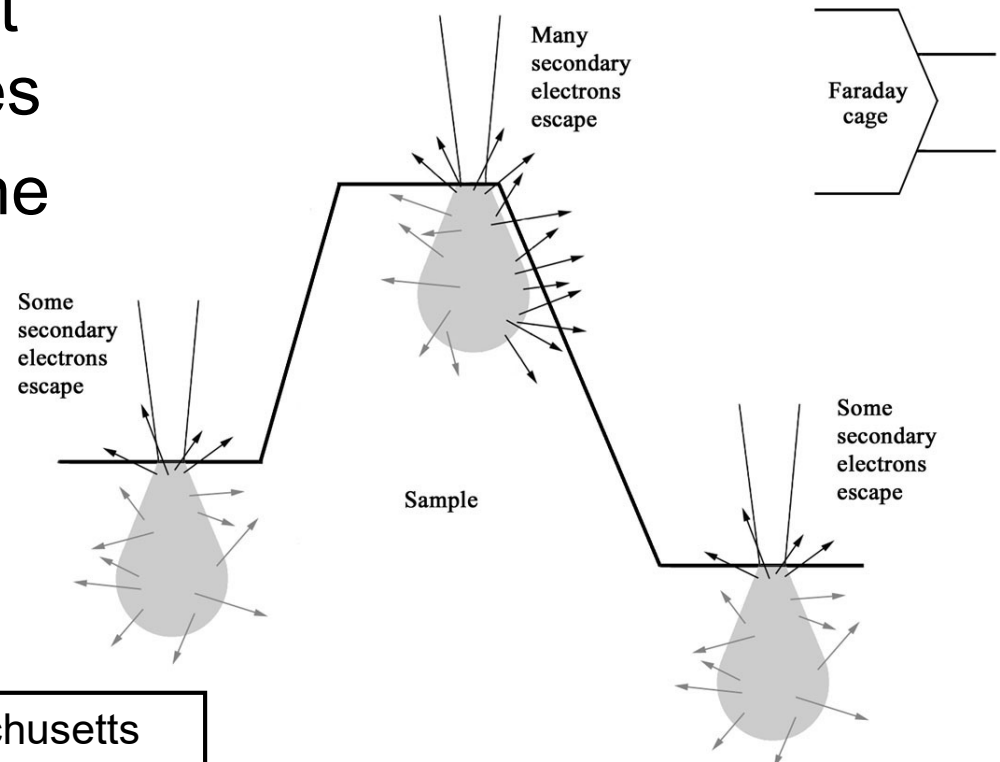
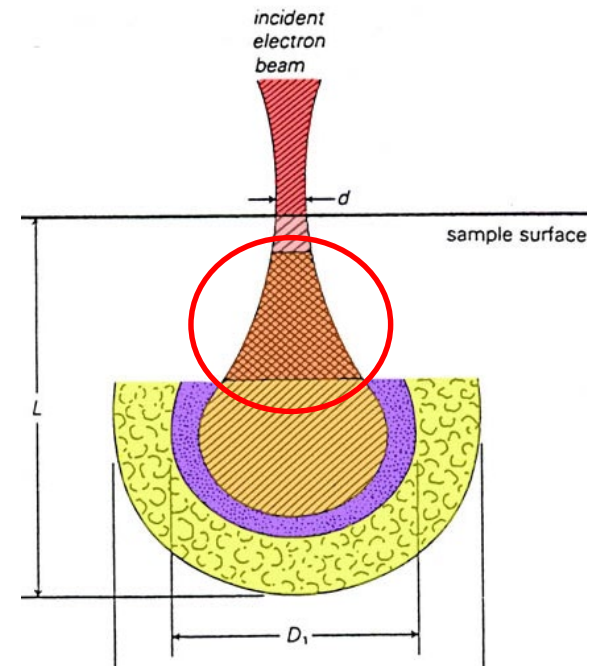
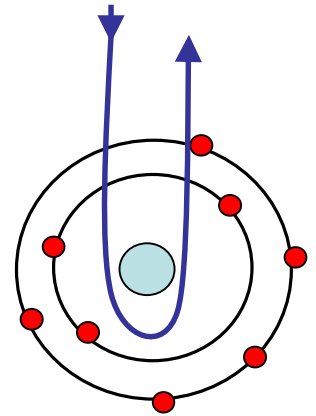


Image: Smith College Northampton, Massachusetts

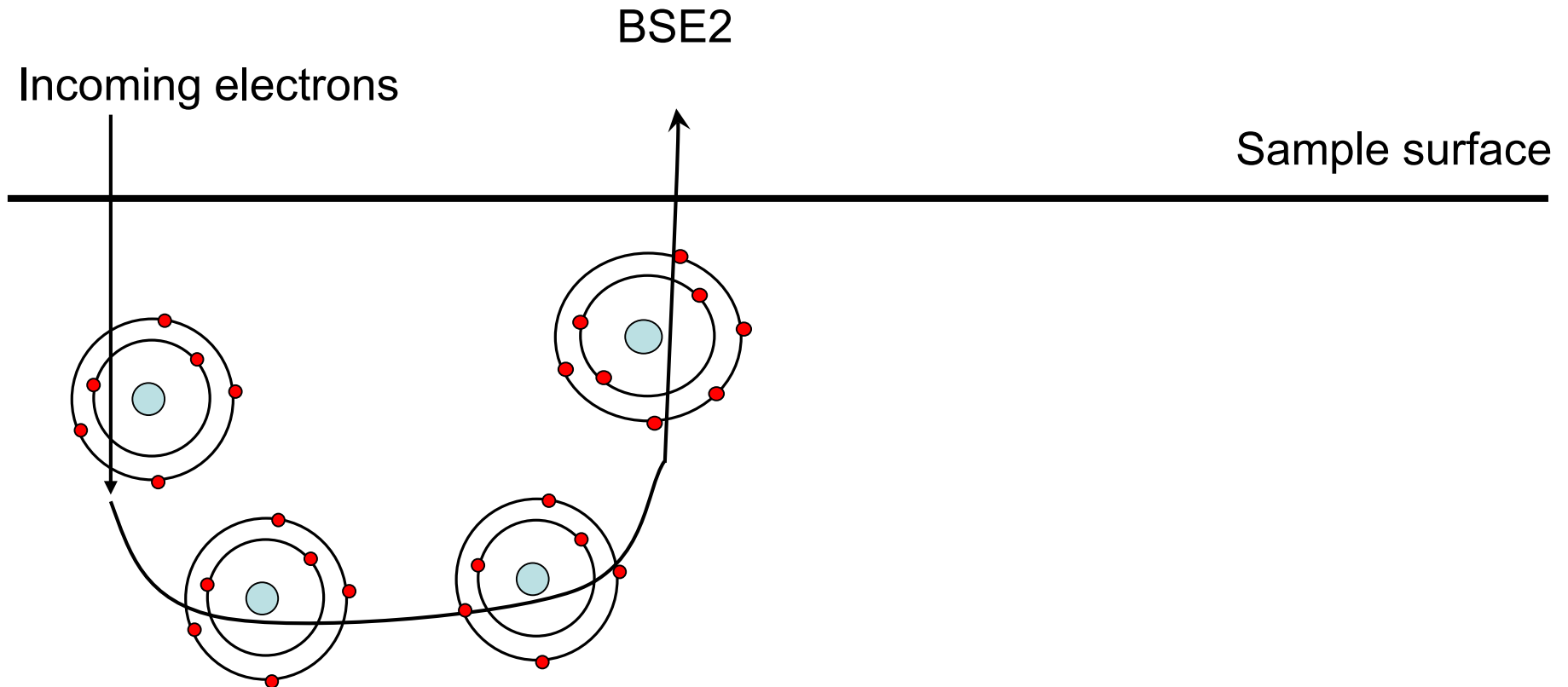
Backscattered electrons (BSE)

- A fraction of the incident electrons is retarded by the electro-magnetic field of the nucleus and if the scattering angle is greater than 180° the electron can escape from the surface



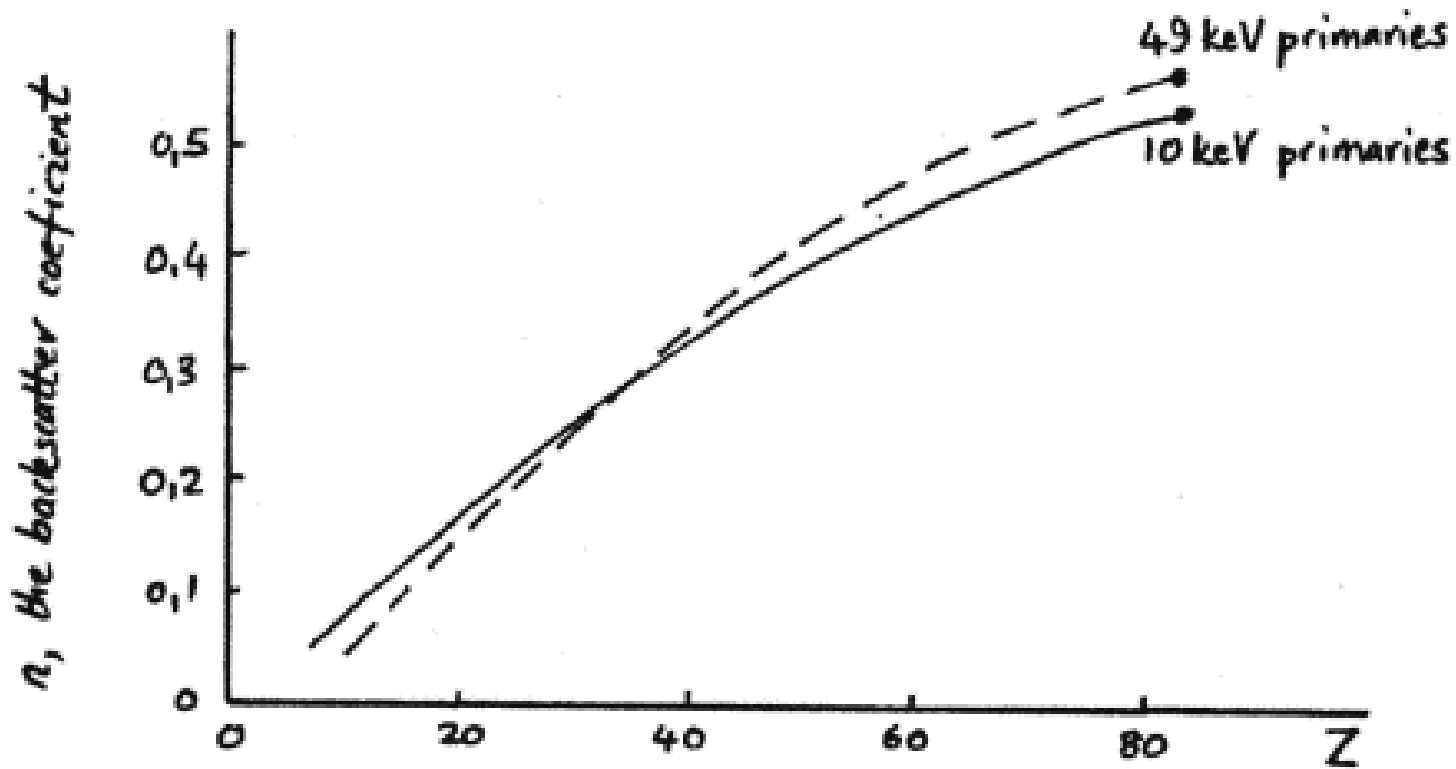
BSE2

- Most BSE are of BSE2 type



BSE as a function of atomic number

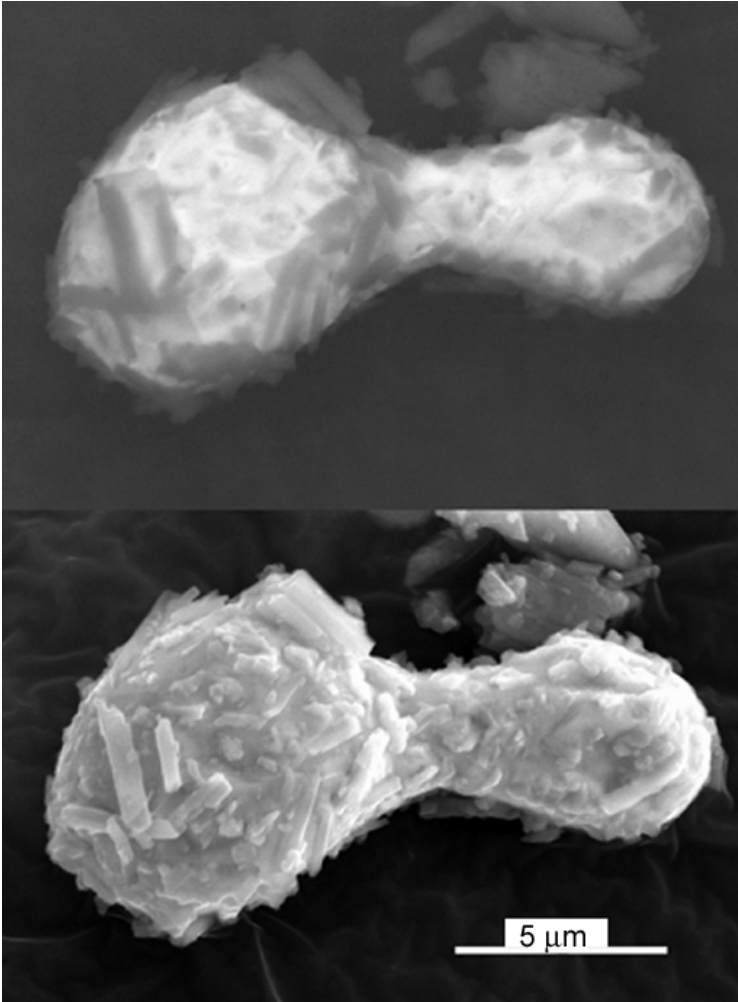
- For phases containing more than one element, it is the average atomic number that determines the backscatter coefficient η



Factors that affect BSE emission

- Direction of the irradiated surface
 - more electrons will hit the BSE detector when the surface is aligned towards the BSE detector
- Average atomic number
- When you want to study differences in atomic numbers the sample should be as levelled as possible (sample preparation is an issue!)

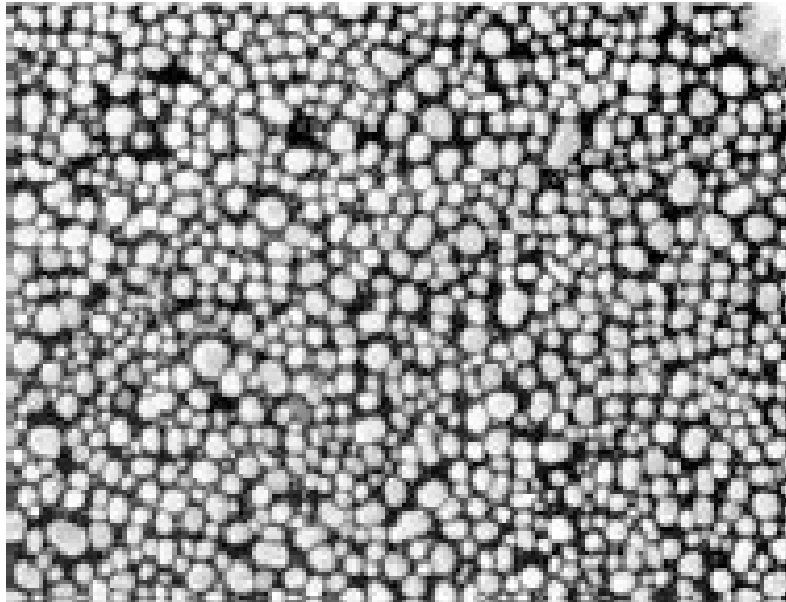
BSE vs SE2



Images: Greg Meeker, USGS

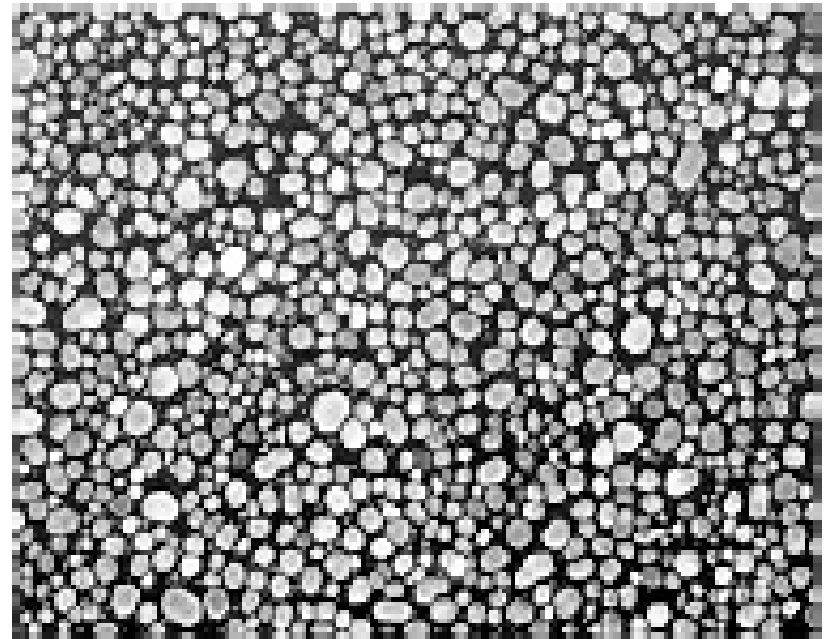
Tungsten SEM images

In Older SEMs High Resolution Meant High kV



(a) 5 kV

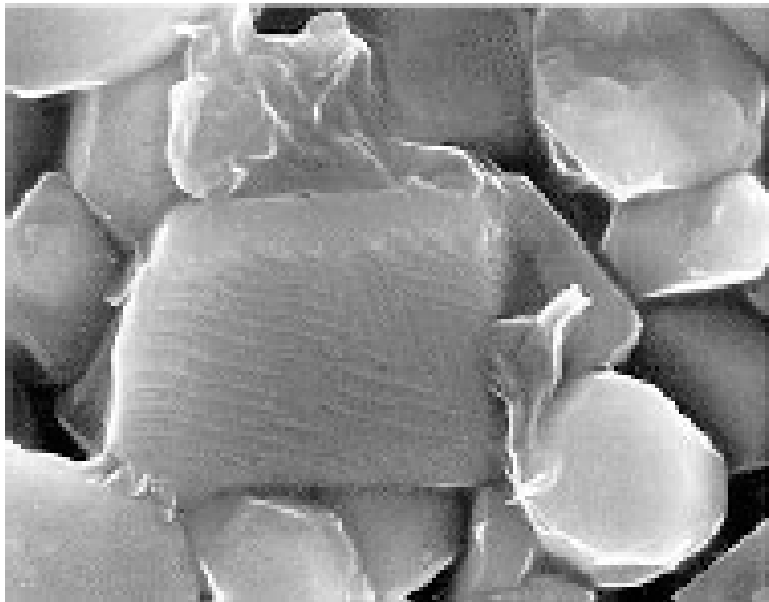
x 36,000



(b) 25 kV

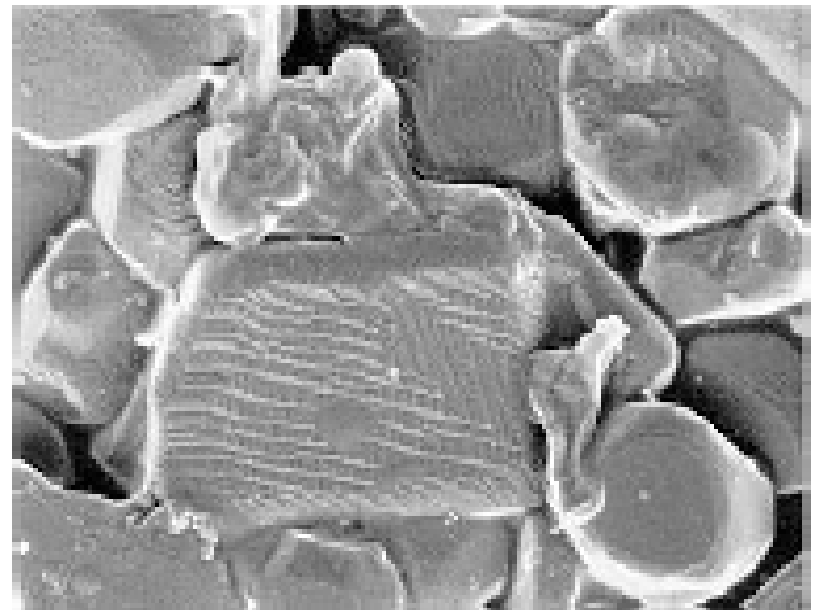
x 36,000

Higher kV can mean large beam penetration & loss of surface detail



(b) 25 kV

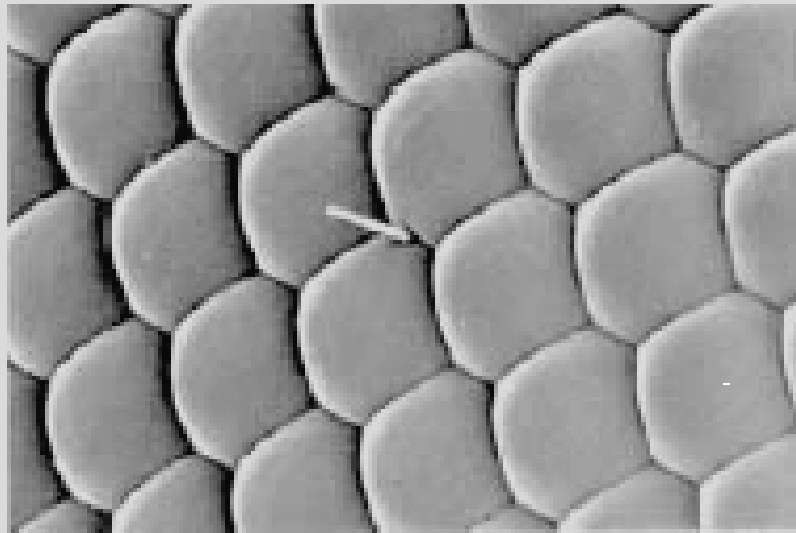
x7,200



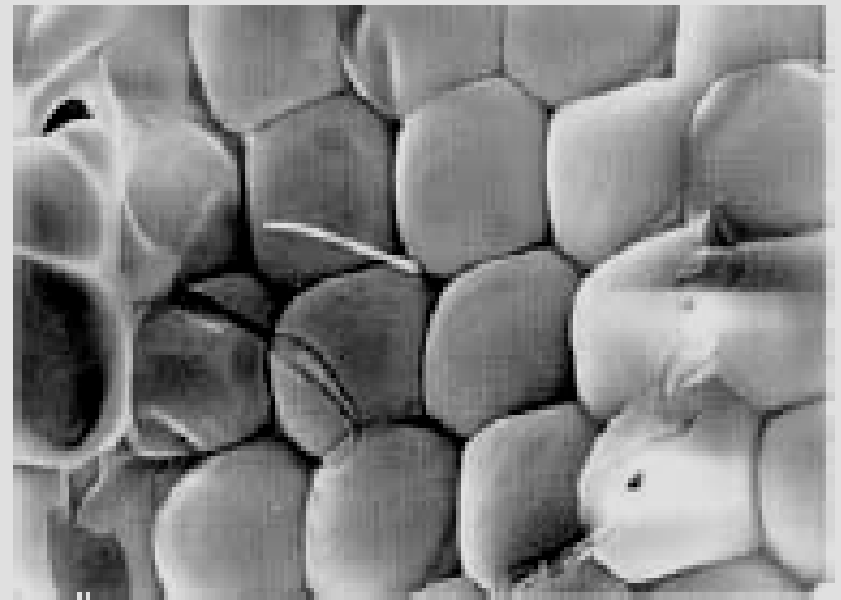
(a) 5 kV

x7,200

It can also mean thermal beam damage to sensitive samples

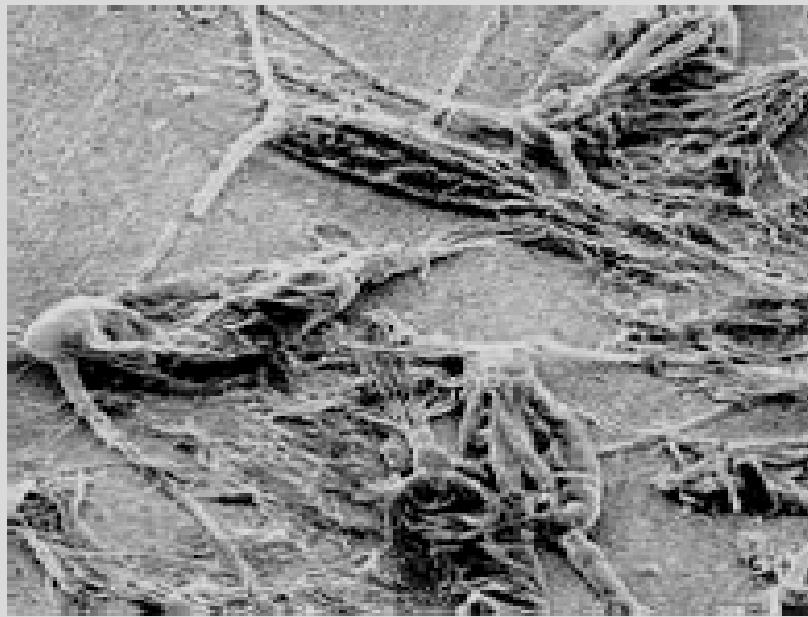


(a) Undamaged specimen

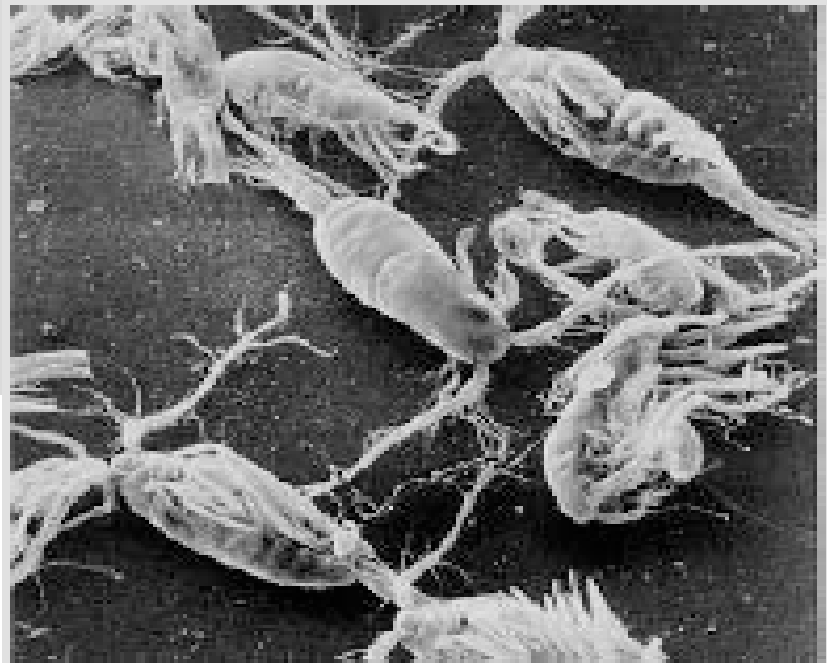


(b) Damaged specimen

And for wet, fragile samples results were often disastrous or sample prep was very difficult



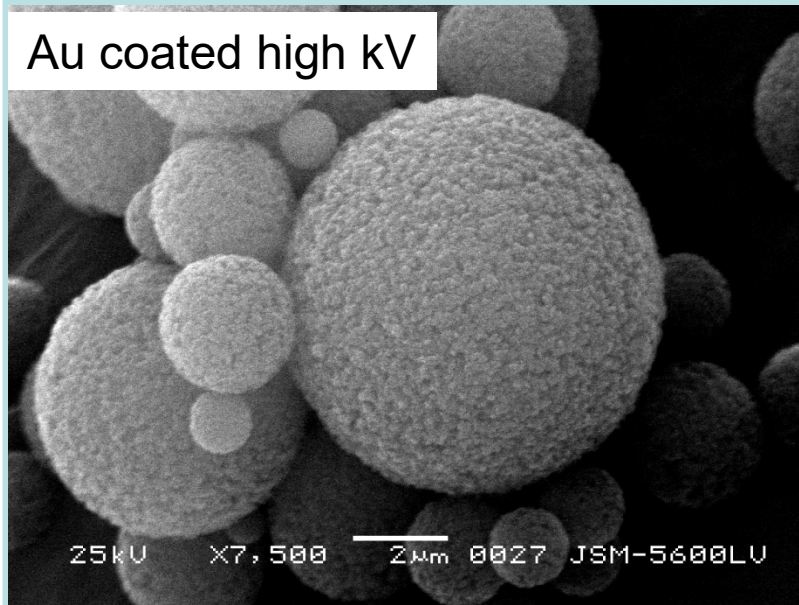
(a) Air drying



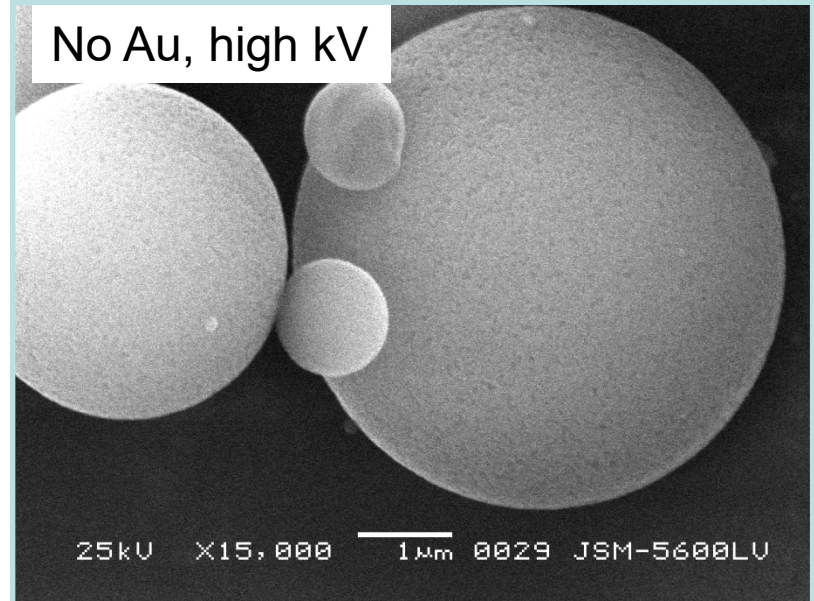
(b) Critical point drying

Coated or Uncoated

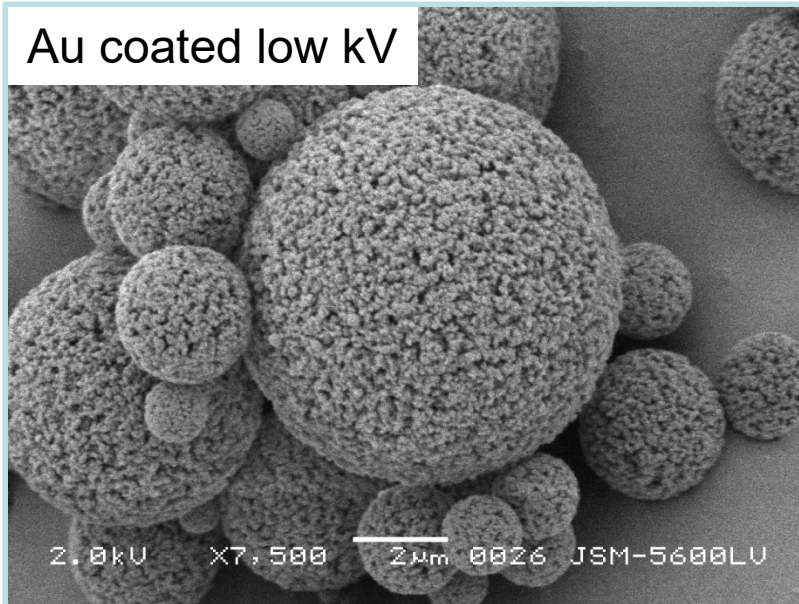
Au coated high kV



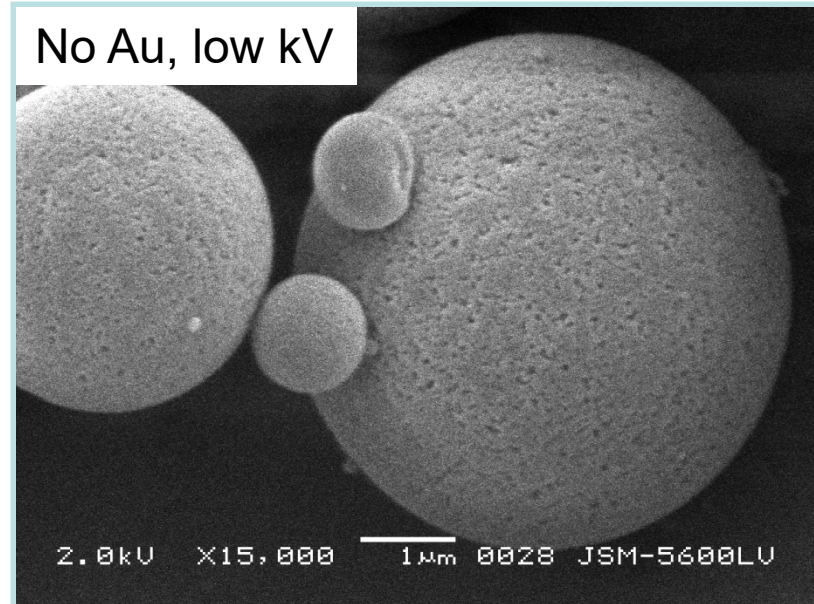
No Au, high kV



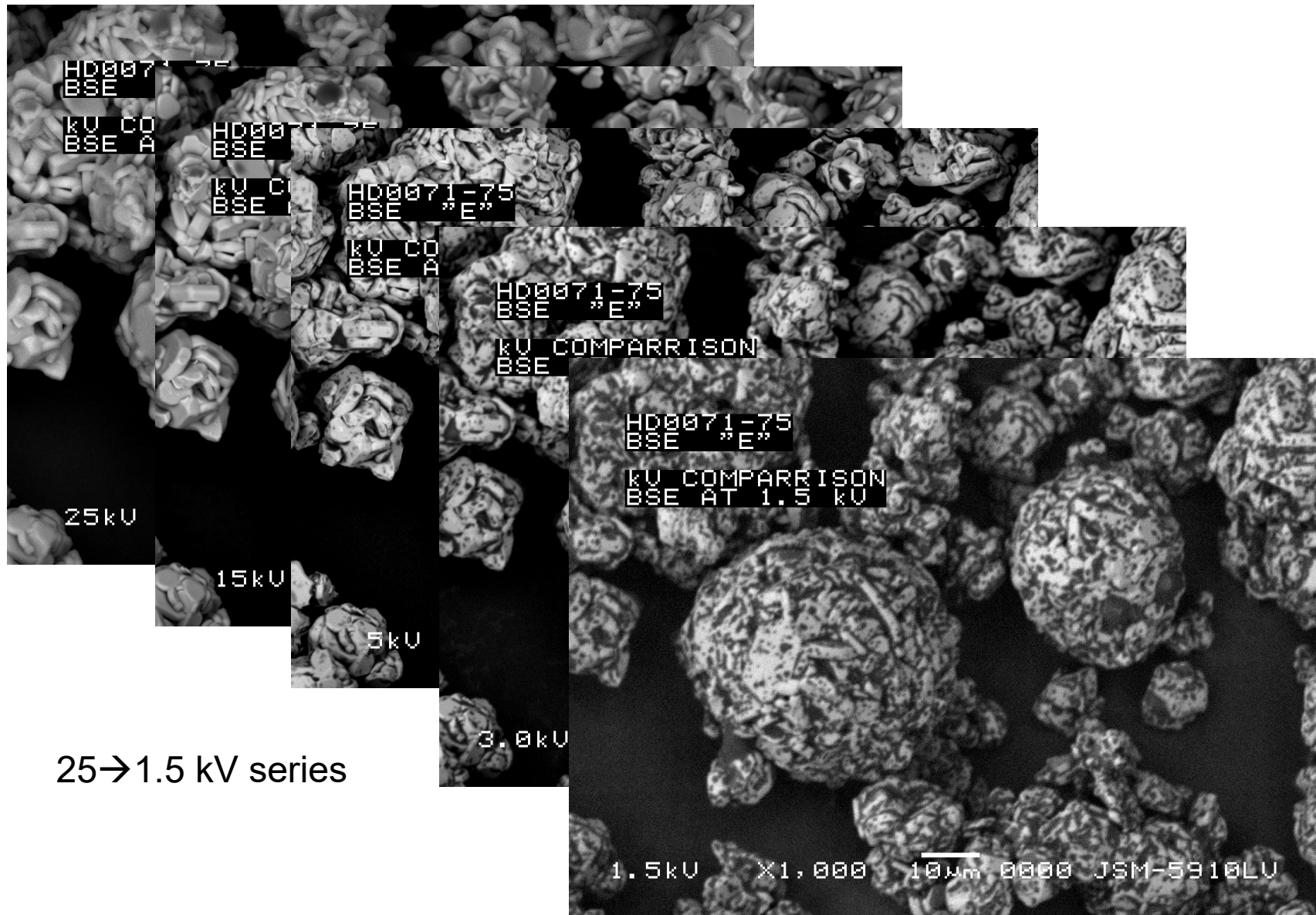
Au coated low kV



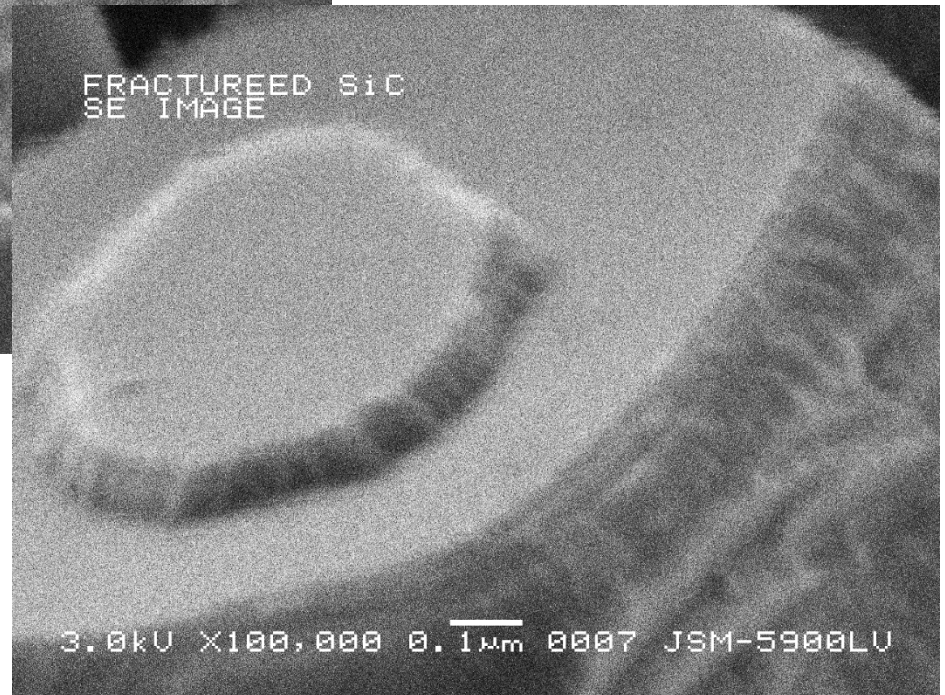
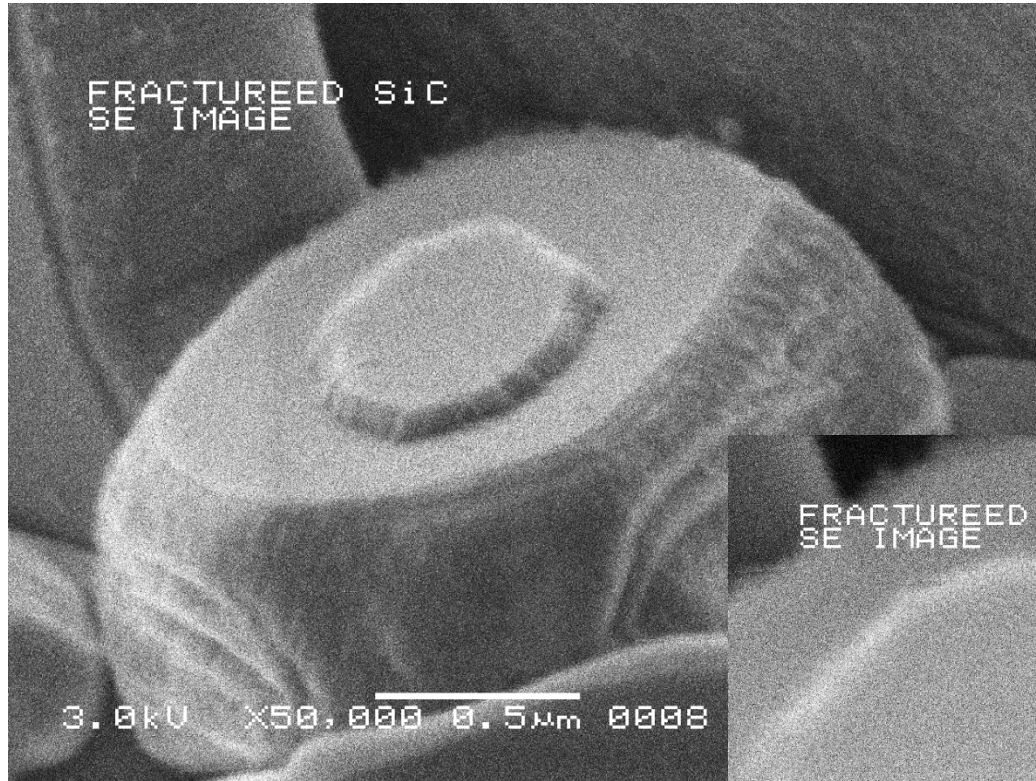
No Au, low kV



Low kV BSE of Polymer coating

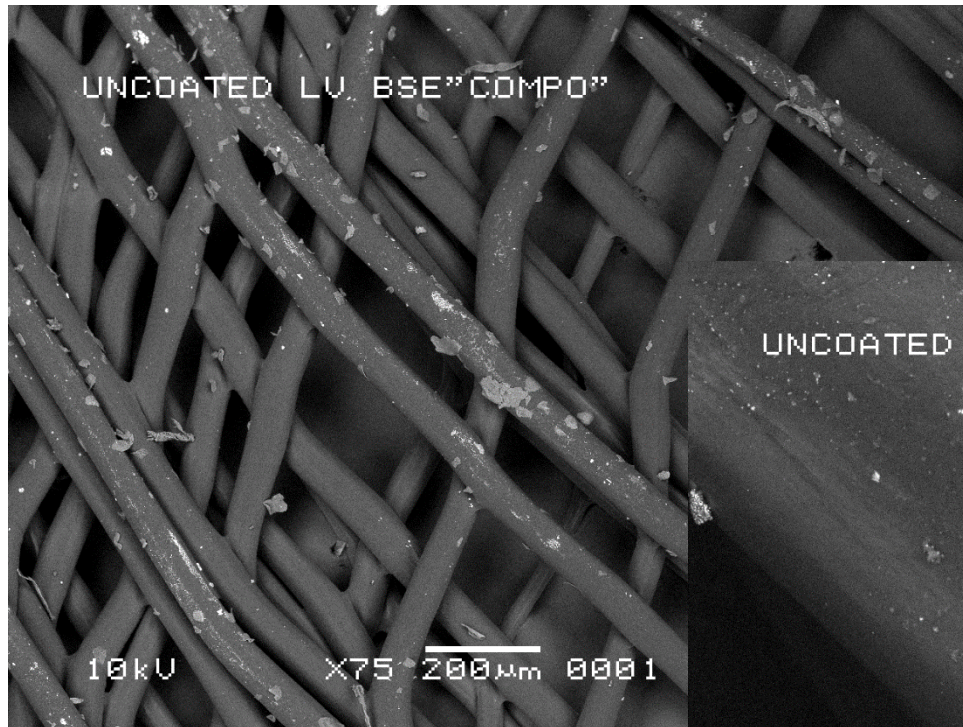


High Resolution Imaging

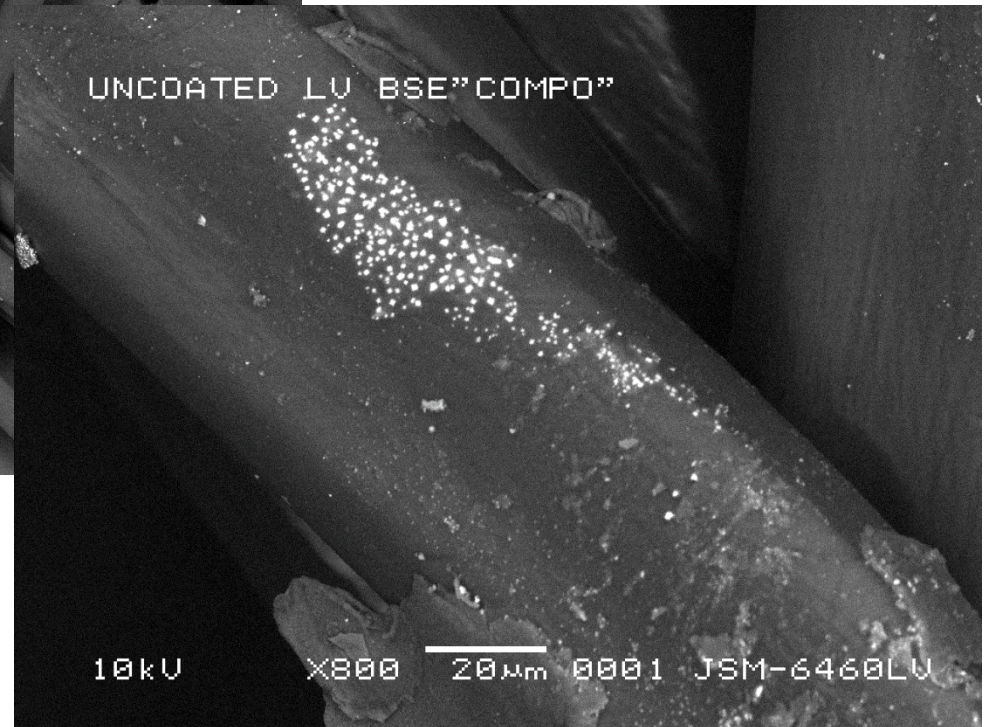


Tungsten LV (low vacuum) SEM images

Spun Polymer Uncoated



10 kV

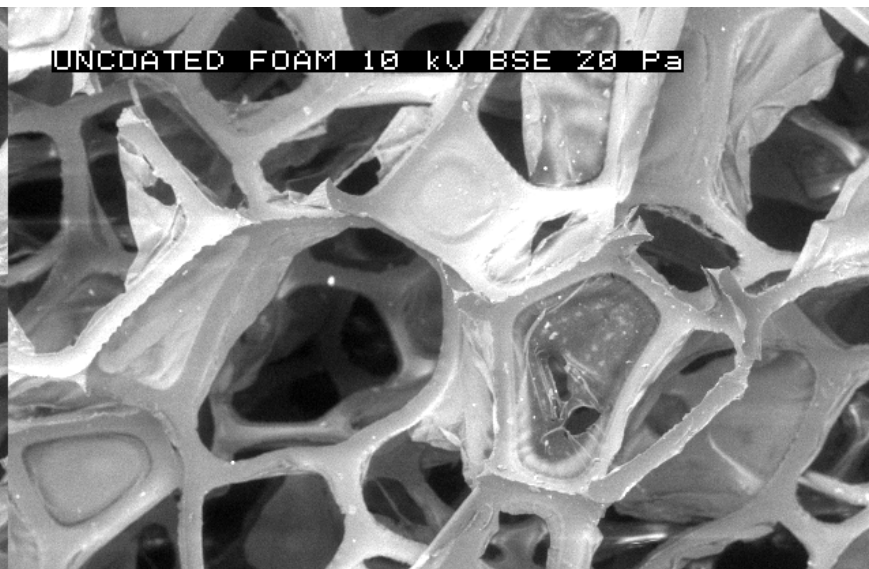


Polyurethane Foam Uncoated (20 kV→3 kV @ 20Pa)



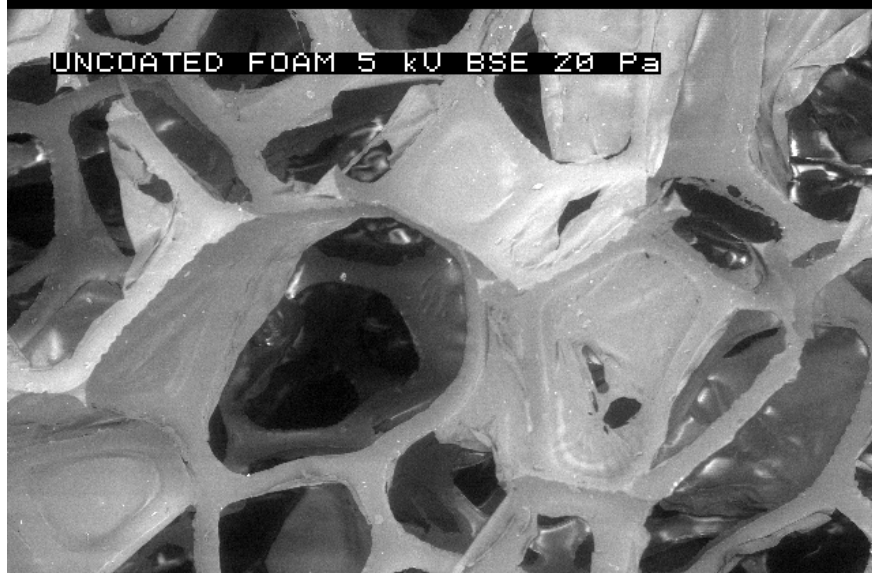
20kV

X50 500μm 0002 JSM-5600LV



10kV

X50 500μm 0003 JSM-5600LV



5kV

X50 500μm 0004 JSM-5600LV

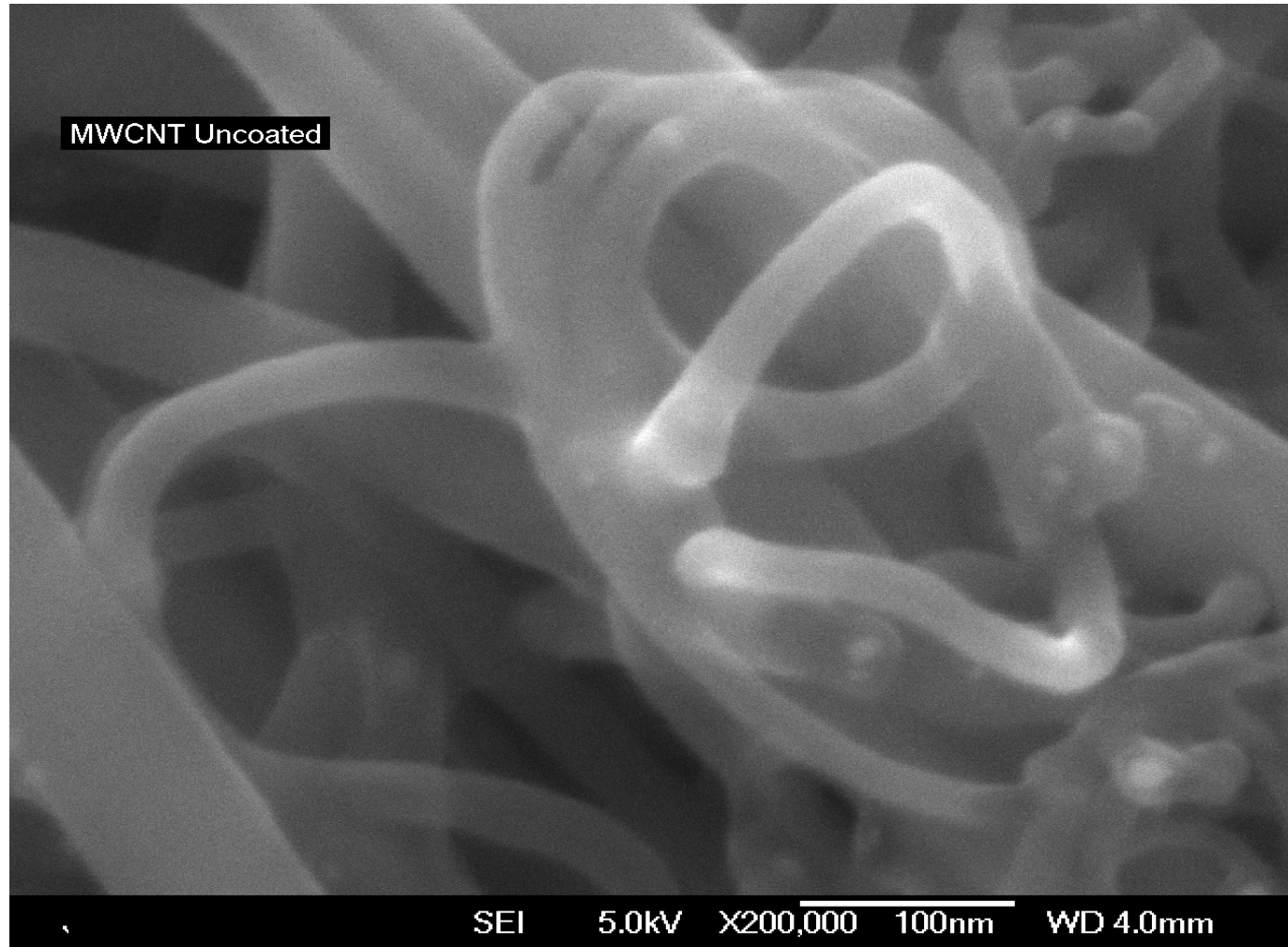


3.0kV

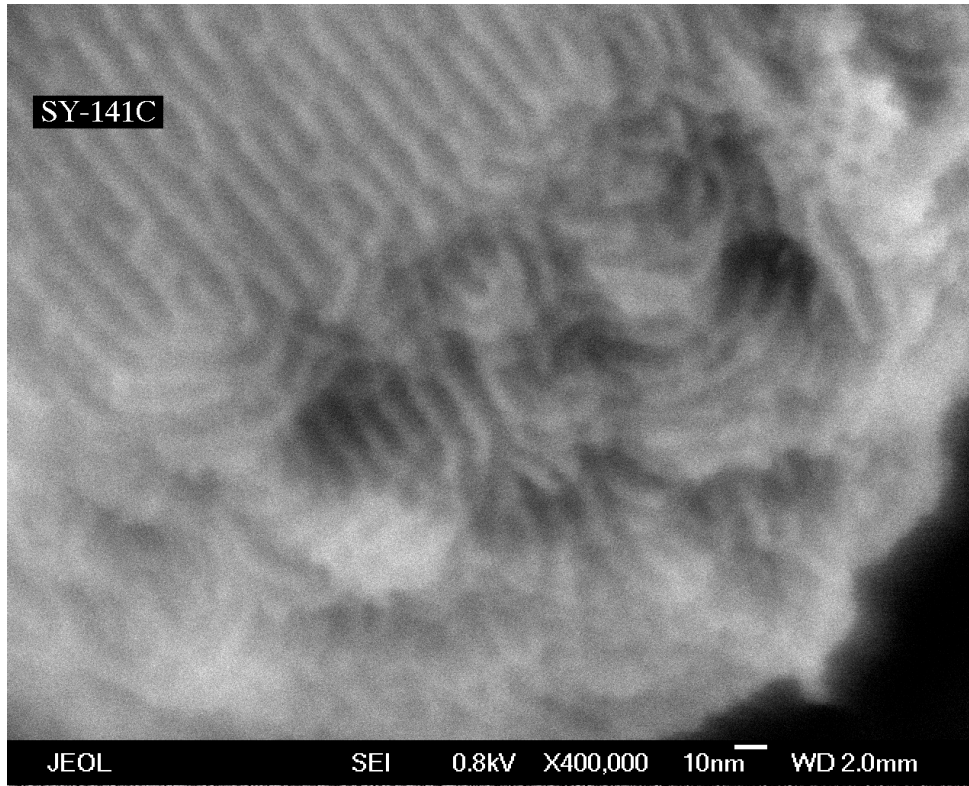
X50 500μm 0005 JSM-5600LV

FEG SEM images

Carbon Nanotubes

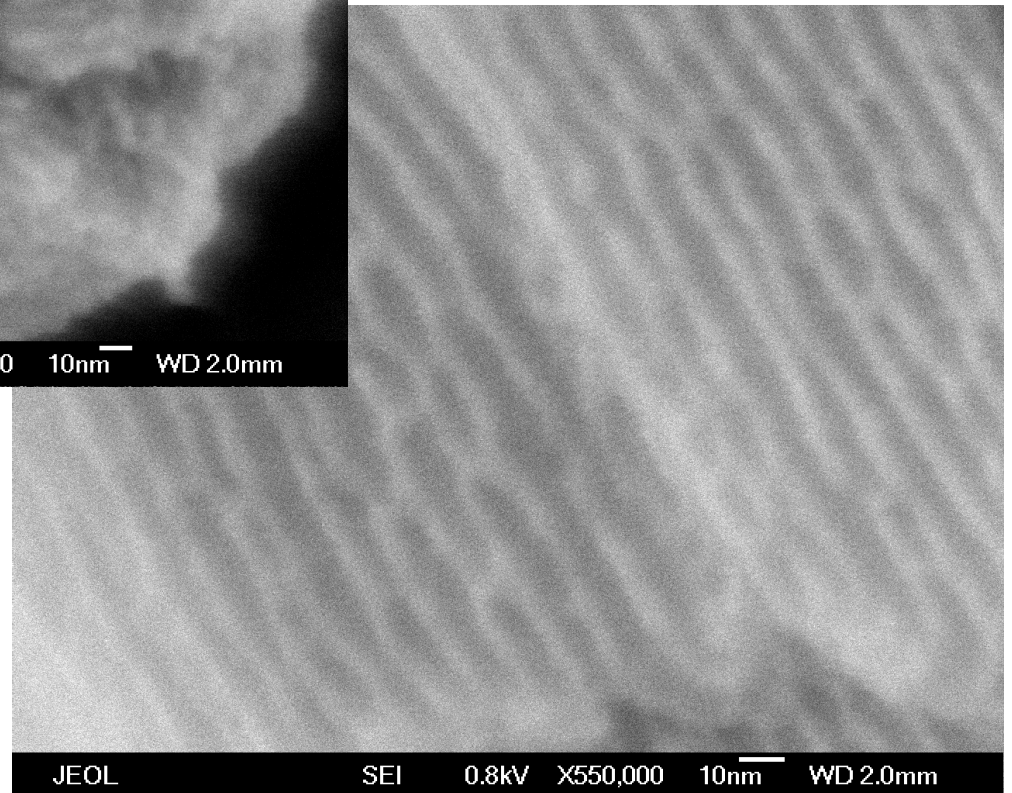


Uncoated

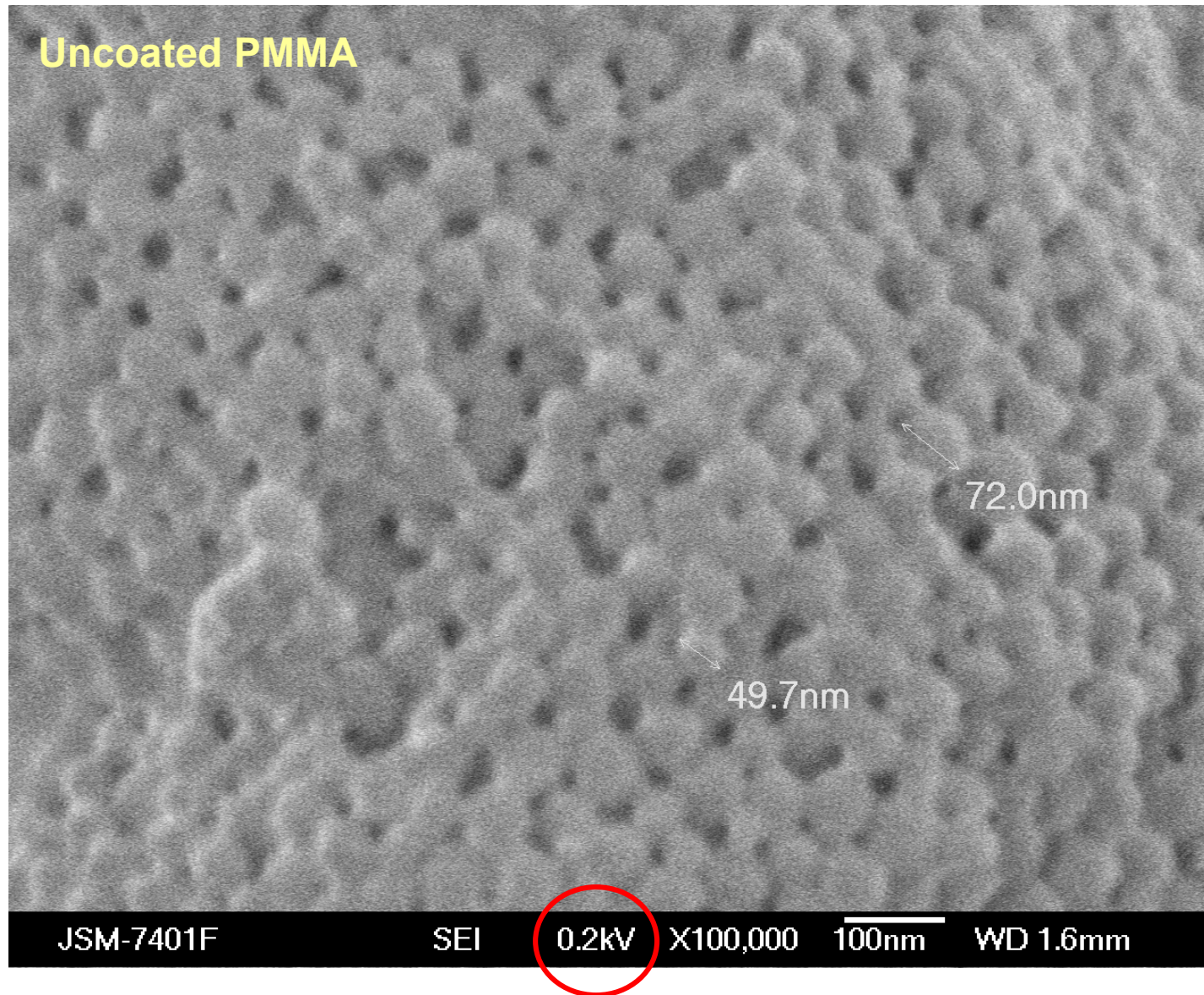


Mesoporous Silica

Low voltage imaging

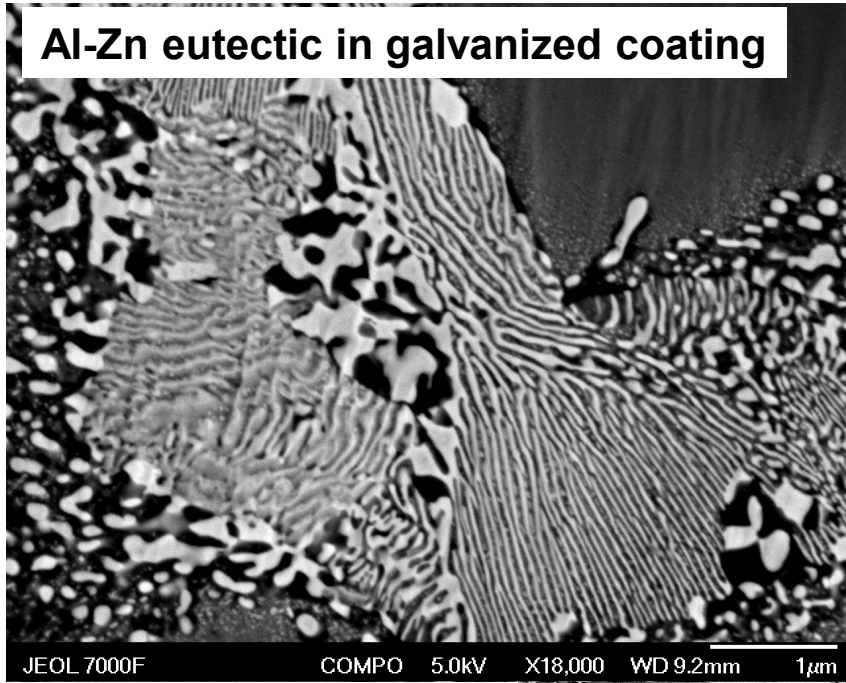


Ultra low kV High Resolution

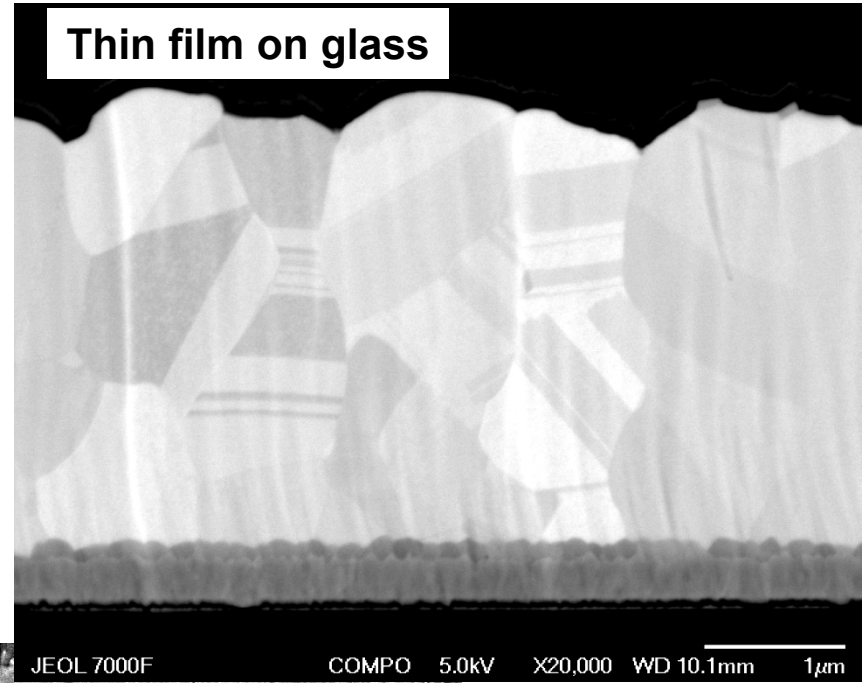


Back-scatter imaging- channeling contrast

Al-Zn eutectic in galvanized coating



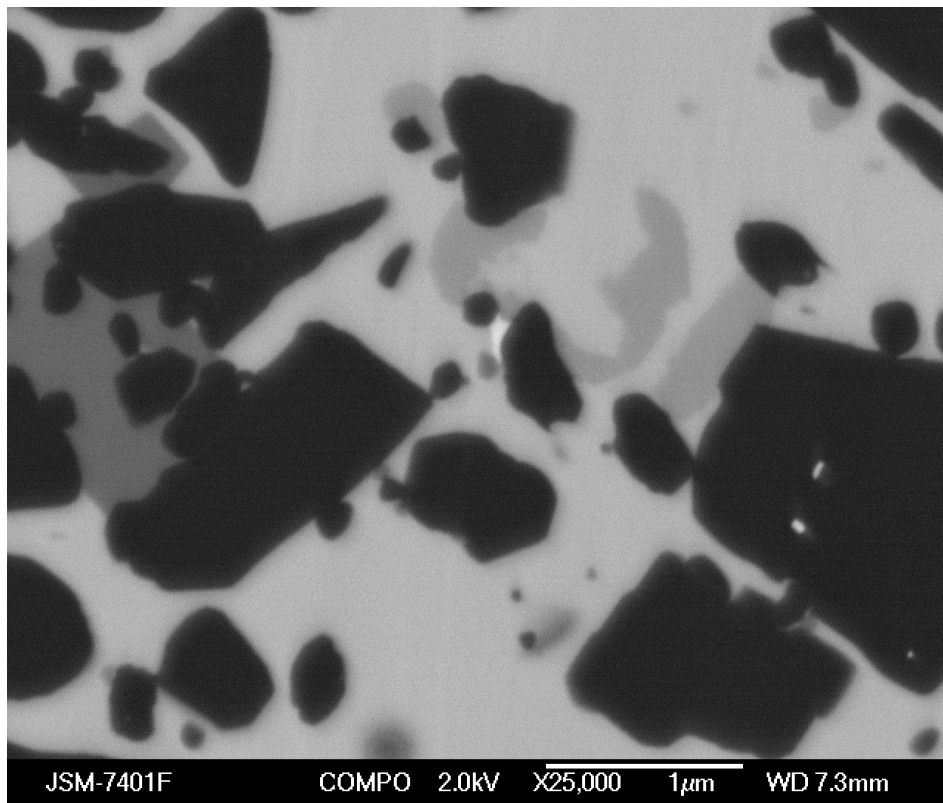
Thin film on glass



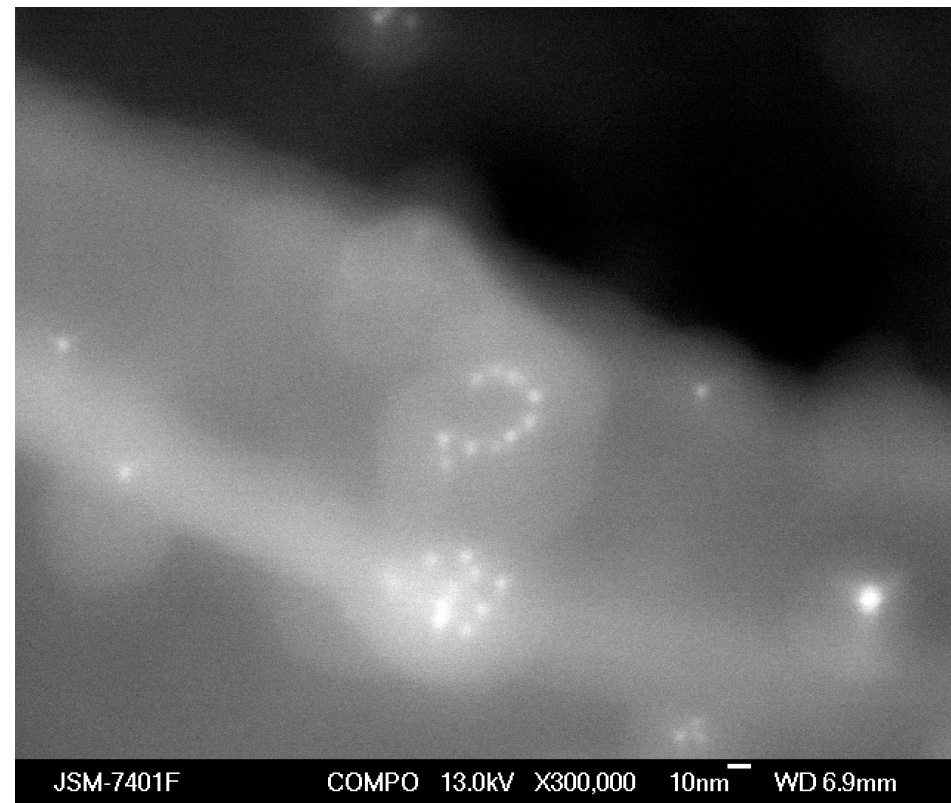
Pb-free solder grain structure



Back-scatter imaging – compositional contrast

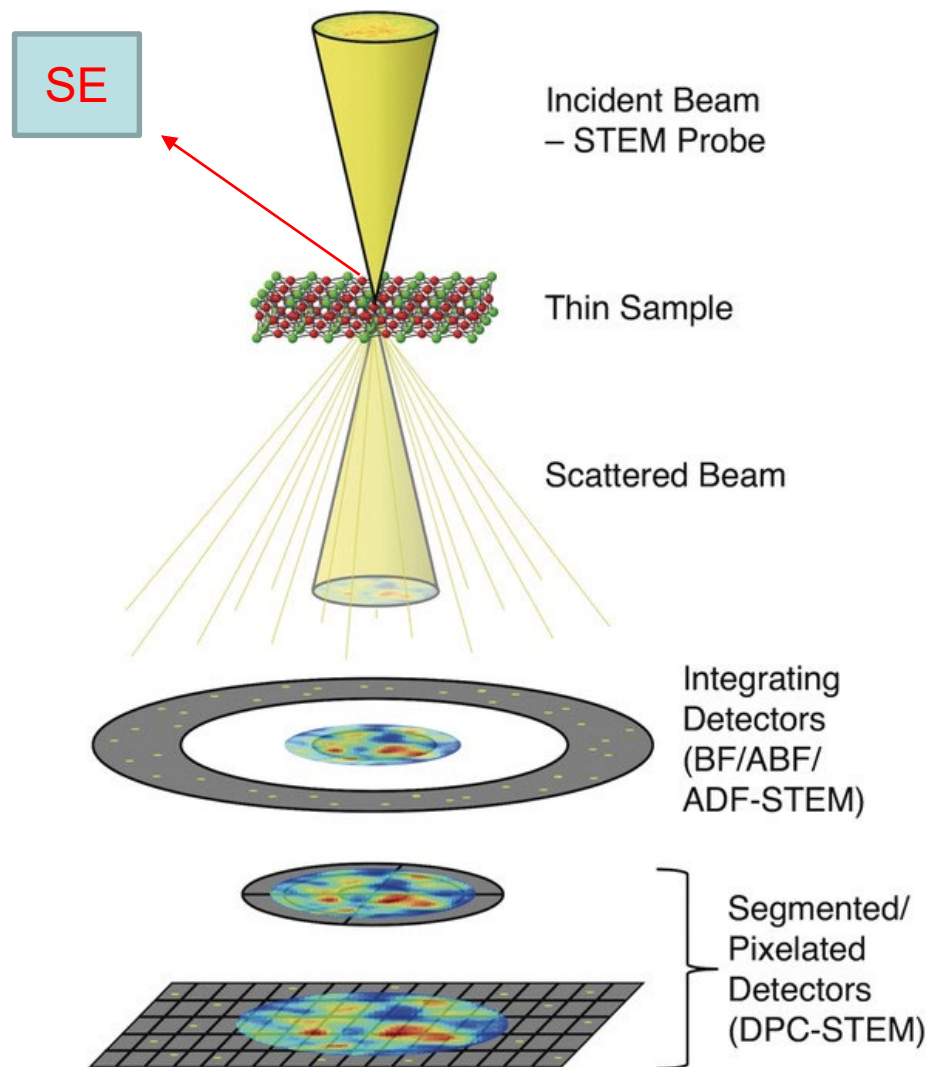


Metal-ceramic composite

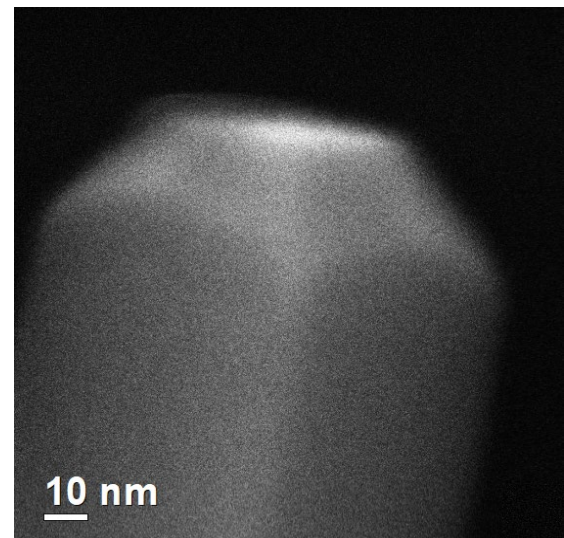
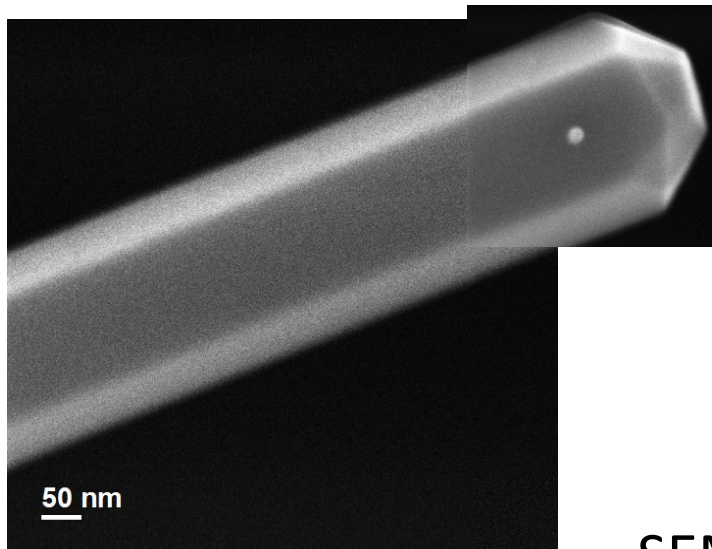
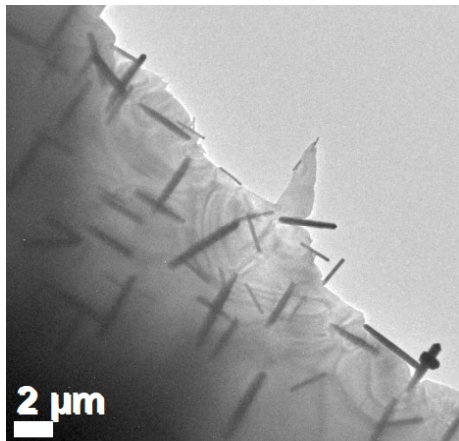


4-6 nm gold immunolabels

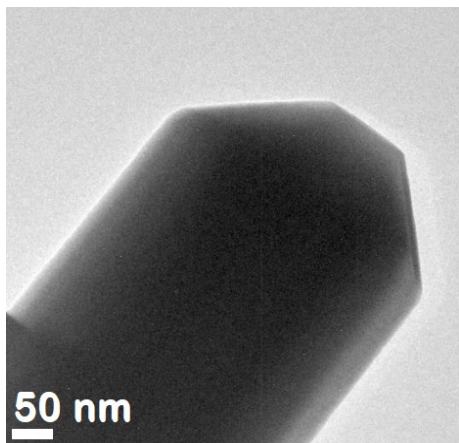
Also, SE detector in TEM (Hitachi, JEOL...)



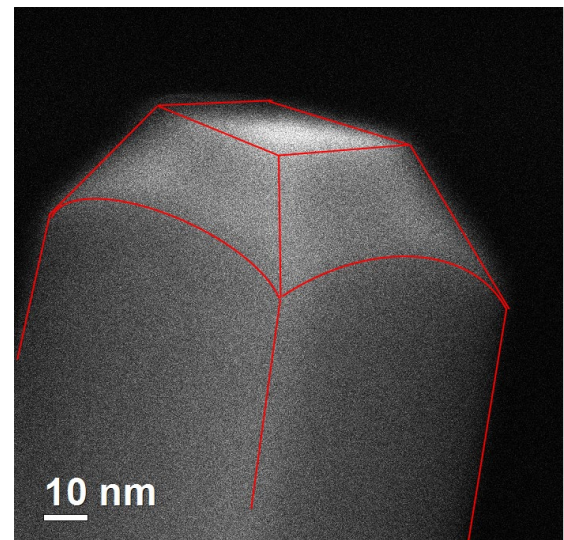
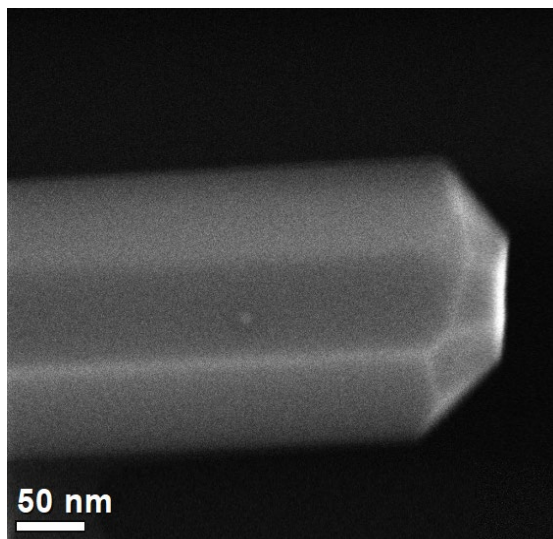
Rods in KTaO_3

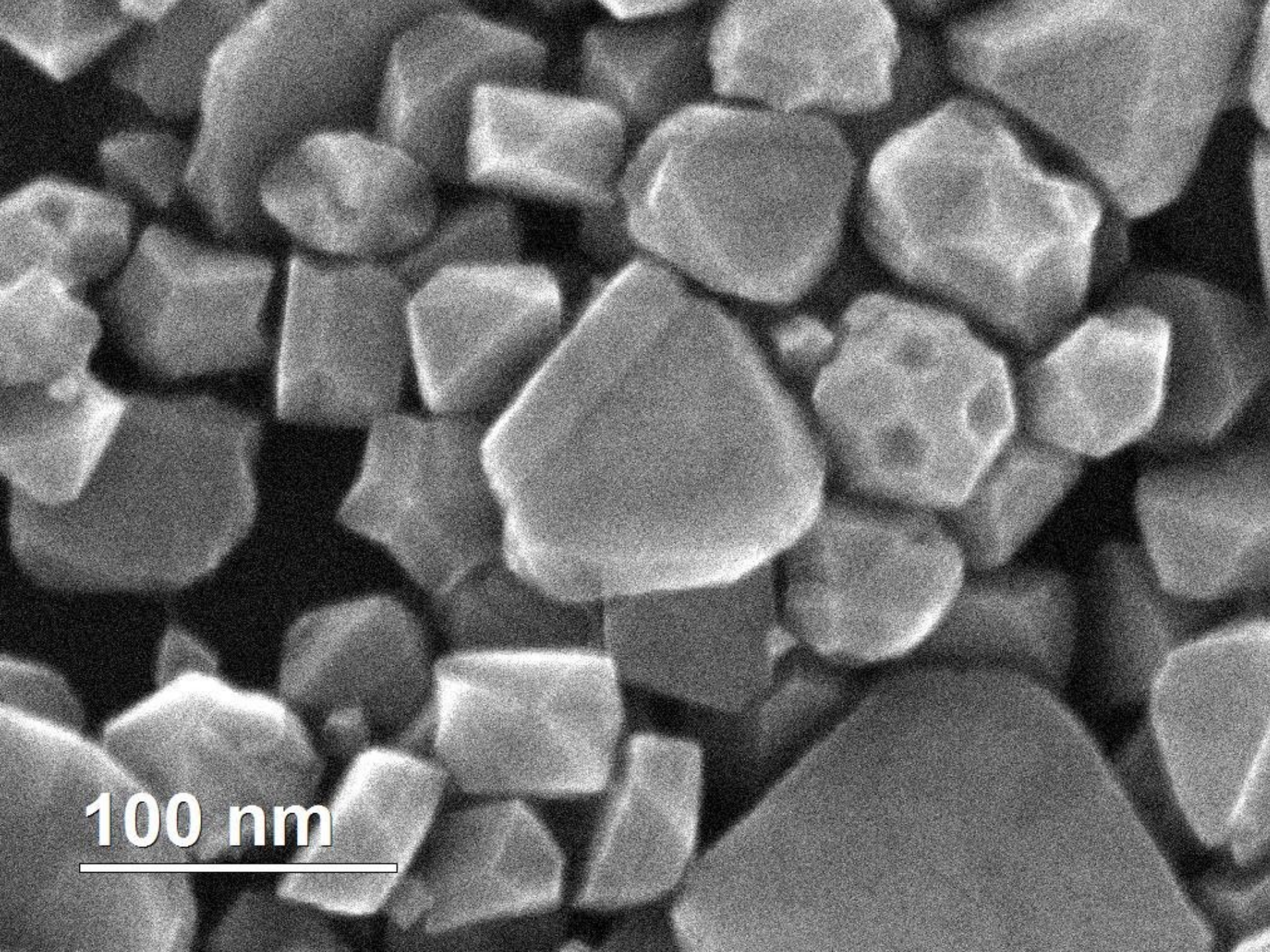


SEM



Bright Field TEM

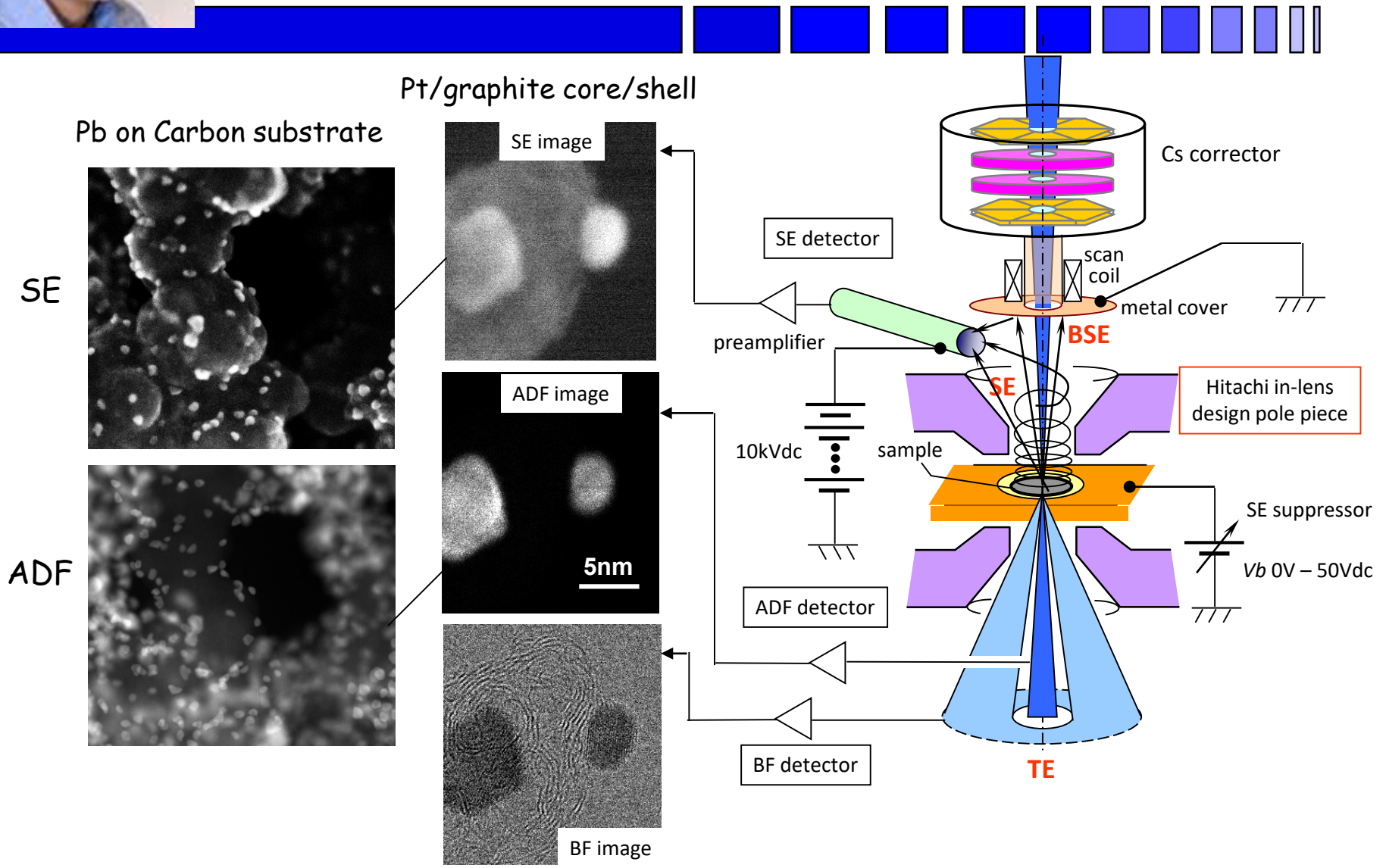




100 nm



Any STEM, just add a SE detector (Hitachi, JEOL...)





nature
materials

LETTERS

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Imaging single atoms using secondary electrons with an aberration-corrected electron microscope

Y. Zhu^{1*}, H. Inada², K. Nakamura² and J. Wall¹

Aberration correction has embarked on a new frontier in electron microscopy by overcoming the limitations of conventional round lenses, providing sub-angstrom-sized probes^{1–4}. However, improvement of spatial resolution using aberration correction so far has been limited to the use of transmitted electrons both in scanning and stationary mode, with an improvement of 20–40% (refs 3–8). In contrast, advances in the spatial resolution of scanning electron microscopes (SEMs), which are by far the most widely used instrument for surface imaging at the micrometre–nanometre scale⁹, have been

about the particles' locations, much of which is lacking in the transmission image. In the past decade or so, high-resolution SEM has proven an indispensable critical-dimension-metrology tool for the semiconductor industry. The semiconductor nanotechnology road map identifies the need for ultrahigh-resolution SEM in the quest for ever-decreasing device sizes¹¹.

We attempted to achieve the highest possible SEM resolution and to determine whether it is limited by the basic physics of secondary production or by the instrumentation. We explored well-defined samples (single uranium atoms) in an instrument

news & views

SCANNING ELECTRON MICROSCOPY

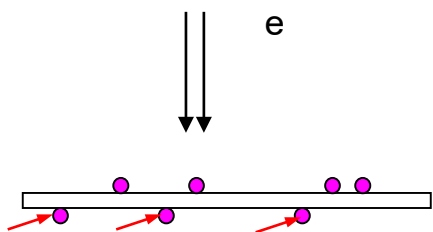
Second best no more

Secondary electron imaging in electron microscopy can achieve resolutions that compete with transmission electron microscopy, and allows imaging of both surface and bulk atoms simultaneously.

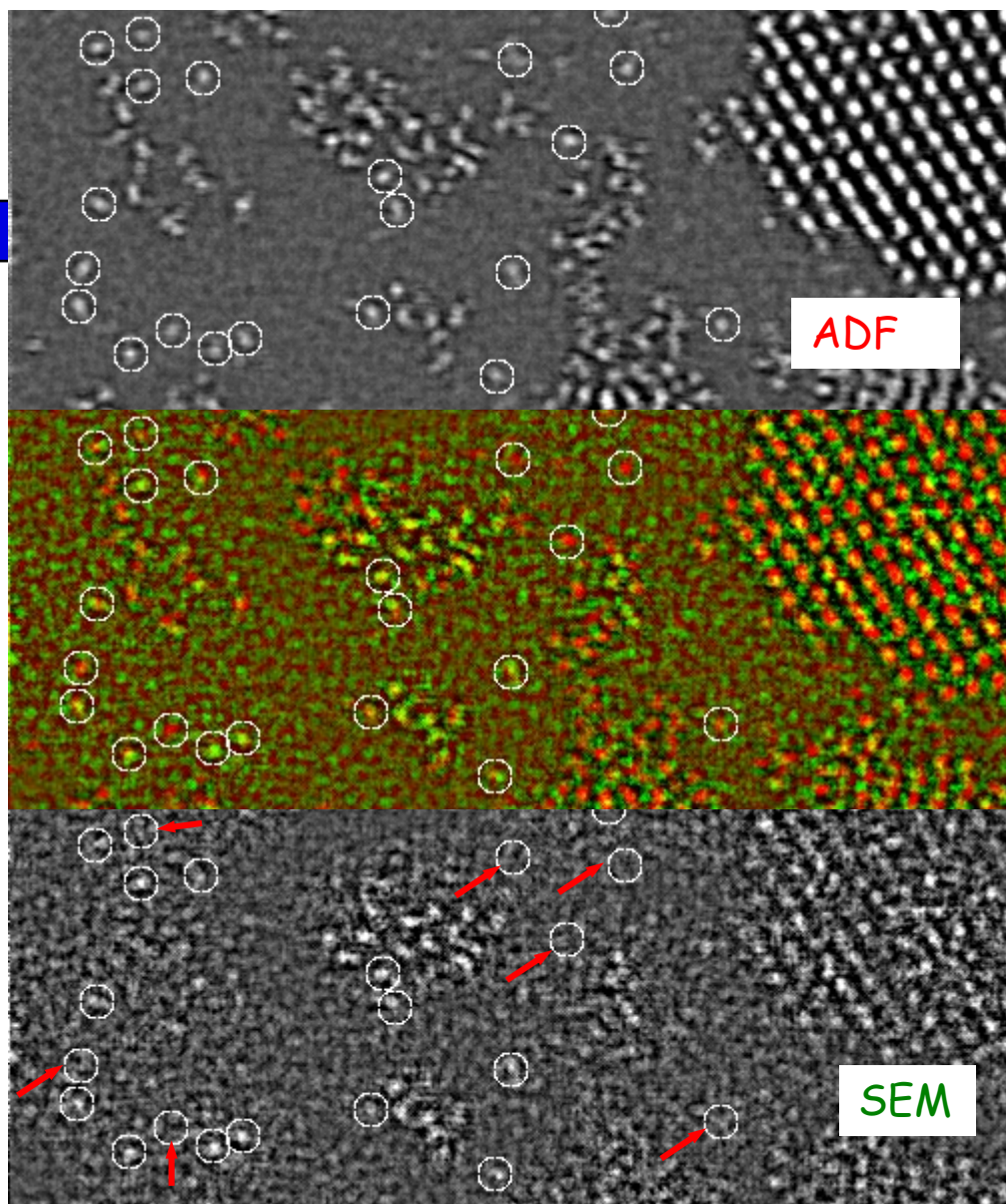
David C. Joy

Secondary electron imaging is the most popular mode of operation of the scanning electron microscope (SEM).

Figure 1 shows a secondary electron image of interconnect lines in a semiconductor device. Each is seen to be outlined by



Imaging surface U atoms



Nature Materials, **8**, 808 - 812 (2009)

Surface Layers Matter (complicated)

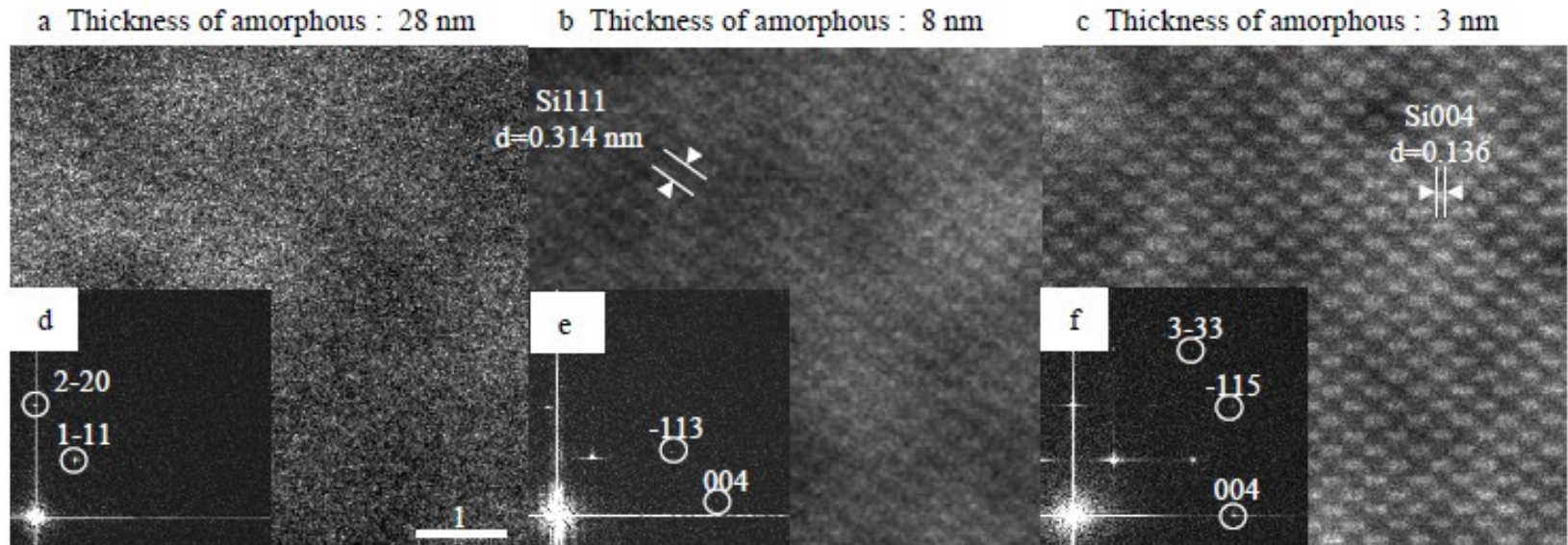


Figure 3. SE images taken with HD-2700 at 200 kV along the Si[011] zone axis with the corresponding FFT of a Si samples prepared by a FIB beam at accelerating voltages of (a) 40 kV , (b) 10 kV and (c) 2 kV.

Summary

- Signals:
 - Secondary electrons (SE): mainly topography
 - Low energy electrons, high resolution
 - Surface signal dependent on curvature
 - Backscattered electrons (BSE): mainly chemistry
 - High energy electrons
 - “Bulk” signal dependent on atomic number
 - Resolution
 - Can be atomic ($\sim 0.2\text{nm}$), a bit complex

